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SEMICONDUCTOR MANUFACTURING INTERNATIONAL CORP Form 6-K October 10, 2008

UNITED STATES SECURITIES AND EXCHANGE COMMISSION Washington, D.C. 20549 Form 6-K REPORT OF FOREIGN PRIVATE ISSUER PURSUANT TO RULE 13a-16 OR 15d-16 UNDER THE SECURITIES EXCHANGE ACT OF 1934 For the month of October, 2008 Commission File Number: 001-31994 Semiconductor Manufacturing International Corporation

(Translation of registrant s name into English)

18 Zhangjiang Road

Pudong New Area, Shanghai 201203

People s Republic of China

(Address of principal executive office)

Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F: b Form 20-F or Form 40-F

Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(1): o

Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(7): o

Indicate by check mark whether the registrant by furnishing the information contained in this Form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934: o Yes b No

If Yes is marked, indicate below the file number assigned to the registrant in connection with Rule 12g3-2(b): n/a

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CAUTIONARY STATEMENT FOR PURPOSES OF THE SAFE HARBOR PROVISIONS OF THE PRIVATE SECURITIES LITIGATION REFORM ACT OF 1995

This interim report may contain, in addition to historical information, forward-looking statements within the meaning of the safe harbor provisions of the U.S. Private Securities Litigation Reform Act of 1995. These forward-looking statements are based on SMIC s current assumptions, expectations and projections about future events. SMIC uses words like believe , anticipate , intend , estimate , expect , project and similar expressions to identify forward-looking statements, although not all forward-looking statements contain these words. These forward-looking statements are necessarily estimates reflecting the best judgment of SMIC s senior management and involve significant risks, both known and unknown, uncertainties and other factors that may cause SMIC s actual performance, financial condition or results of operations to be materially different from those suggested by the forward-looking statements including, among others, risks associated with cyclicality and market conditions in the semiconductor industry, risks of litigation, intense competition, timely wafer acceptance by SMIC s customers, timely introduction of new technologies, SMIC s ability to ramp new products into volume, supply and demand for semiconductor foundry services, industry overcapacity, shortages in equipment, components and raw materials, availability of manufacturing capacity and financial stability in end markets.

Except as required by law, SMIC undertakes no obligation and does not intend to update any forward-looking statement, whether as a result of new information, future events or otherwise.

ADDITIONAL INFORMATION

References in this interim report to:

Company or SMIC are to Semiconductor Manufacturing International Corporation;

China or the PRC are to the People s Republic of China, excluding for the purpose of this interim report, Hong Kong, Macau and Taiwan;

EUR are to Euros;

HK\$ are to Hong Kong dollars;

Rmb are to Renminbi, the legal currency of China;

US\$ or USD are to U.S. dollars;

SEHK or Hong Kong Stock Exchange are to The Stock Exchange of Hong Kong Limited

SEC are to the U.S. Securities and Exchange Commission;

NYSE or New York Stock Exchange are to the New York Stock Exchange, Inc.;

2008 AGM are to the Company s Annual General Meeting held on June 2, 2008; and

global offering are to the initial public offering of our ADSs and our ordinary shares, which offering was completed on March 18, 2004.

All references in this interim report to silicon wafer quantities are to 8-inch wafer equivalents, unless otherwise specified. Conversion of quantities of 12-inch wafers to 8-inch wafer equivalents is achieved by multiplying the number of 12-inch wafers by 2.25. When we refer to the capacity of wafer fabrication facilities, we are referring to the installed capacity based on specifications established by the manufacturers of the equipment used in those facilities. References to key process technology nodes, such as 0.35 micron, 0.25 micron, 0.18 micron, 0.15 micron, 0.13 micron, 90 nanometer, and 65 nanometer include the stated resolution of the process technology, as well as intermediate resolutions down to but not including the next key process technology node of finer resolution. For example, when we state 0.25 micron process technology, that also includes 0.22 micron, 0.21 micron, 0.20 micron and 0.19 micron technologies. 0.18 micron process technology also includes 0.17 micron and 0.16 micron technologies;

0.15 micron process technology includes 0.14 micron technology; and 0.13 micron process technology includes 0.11 micron and 0.10 micron technologies. References to U.S. GAAP mean the generally accepted accounting principles in the United States. Unless otherwise indicated, our financial information presented in this interim report has been prepared in accordance with U.S. GAAP.

Chairman s Statement

Dear Shareholders,

The Chinese semiconductor industry has been experiencing rapid growth in the past several years and has now become one of the fastest growing markets in the world. Within such a dynamic and exciting market, SMIC, the third largest foundry in the world, is well positioned to capture this growth by leveraging its proven technology and building upon its local and international customer base.

We are pleased with the progress of our various strategic initiatives in the first half of 2008. Our effort in converting our DRAM into logic capacity is going full speed and will better position us to deliver for our customers. Next, the addition of our Shenzhen fab will enable us to grow our strategic partnerships and expand our customer base within China. Our operations in Beijing, Shanghai, Tianjin, Chengdu, Wuhan and Shenzhen will enable us to better service our customers, improve operational efficiency, and further capture the growth opportunities in China. Finally, we are continuing our advanced technology research and development as this will be key to our future success in meeting our customers demand. Our collaboration with IBM on the 45nm development is on track, and we have commenced the 65nm internal library development. We are confident with our overall strategic direction in light of these recent advances.

High-level transparency, accountability, and adherence to international standards of corporate governance continue to be important pillars for SMIC as a world-class foundry. As a publicly listed company on both the New York Stock Exchange and The Stock Exchange of Hong Kong Limited, we have complied with various requirements including the Sarbanes-Oxley Act of 2002. We continually strive to achieve the best-practice in corporate governance and in corporate disclosure in order to enhance our shareholder value on a sustainable basis.

By leveraging our firm business values with our solid business strategy, we are well positioned for continued growth and development and the further strengthening of our position in Mainland China.

Sincerely,

Yang Yuan Wang Chairman of the Board Shanghai, PRC September 19, 2008

Chief Executive Officer s Statement

Dear Shareholders,

For the first six months of 2008 our total revenue declined to US\$705.3 million as compared to US\$763.1 million for the first six months of 2007 as we exited the commodity DRAM business. However, in the first six months of 2008 we shipped 40% more logic wafers compared to the first six months of 2007, and our second quarter losses were significantly narrowed to \$45.6 million from a \$224.8 million loss in the first quarter which included an impairment loss of \$105.8M.

The first six months losses were primarily due to the fact that we exited the commodity DRAM business and are in transitioning from DRAM production to logic production in our Beijing facility.

The process of converting DRAM capacity into logic has been successful. A number of new logic tape-outs with high yield are now in customer qualification and a few have entered into production. The ramp-up of our logic capacity remains critical to our strategy, as it will better position us to match the market demand for our services.

In the second quarter, we witnessed rather strong customer demand, despite the severe macroeconomic situation in the U.S. The demand for our 8-inch fab logic service was very strong for the second quarter, particularly in

communications and consumer market segments. On a regional basis, revenue from North America remains solid, while revenue from the Asia Pacific region, including Mainland China and Taiwan, has seen the highest growth. We are continuing our efforts in developing advanced technology nodes to meet the needs of our customers. We have commenced our internal 65nm library and bit cell development, and our 45nm collaboration with IBM is proceeding on schedule. I am also pleased to report the signing of a strategic agreement with Spansion on the 43nm Flash technology.

We are pleased to see strong progress being made by our Chinese customers. We continue to serve a few customers with our 90nm technology process, and have also engaged customers at the 65nm technology node. One customer announced that their new RFID product, which was manufactured in our factory, received EPC Global official certification this month. This is the first Chinese-made RFID product to receive this international certification. Another customer started mass production of their 3G CMMB mobile TV chipset in the second quarter in our fab. The demand appears to be strong and should continue throughout to the rest of the year. Moving forward, we will continue to strengthen our local advantage in China by furthering our collaboration with local fabless design houses. We are also pleased with our profitable solar business and approved expansion plan. We aim to expand our solar capacity five to six times our current production output in the first half of 2009.

As we continue to execute on our growth plans, we believe we will continue to create value for our customers worldwide and further enhance shareholder value in the coming years.

May God bless you and SMIC,

Richard R. Chang

Chief Executive Officer Shanghai, PRC September 19, 2008

Corporate Information

Registered name	Semiconductor Manufacturing International Corporation
Chinese name	
Registered office	PO Box 309 Ugland House George Town, KY1-1104 Cayman Islands
Head office and place of business in PRC	18 Zhangjiang Road Pudong New Area Shanghai 201203 PRC
Place of business in Hong Kong registered under Part XI of the Companies Ordinance	Suite 3003, 30th Floor No. 9 Queen s Road Central Hong Kong
Website address	http://www.smics.com
Company secretary	Anne Wai Yui Chen
Authorized representatives	Richard R. Chang Anne Wai Yui Chen
Places of listing	Hong Kong Stock Exchange New York Stock Exchange
Name of share	Semiconductor Manufacturing International Corporation
Stock code	0981 (SEHK) SMI (NYSE)
* For identification	

identification purposes only

Management s Discussion and Analysis of Financial Condition and Results of Operations

The Board of Directors (the Board) of Semiconductor Manufacturing International Corporation (the Company) would like to announce the unaudited interim results of operations of the Company and its subsidiaries for the six months ended June 30, 2008, and would like to express their gratitude to the shareholders and their staff for the support of the Company.

Sales

Sales decreased by 7.6% from US\$763.1 million for the six months ended June 30, 2007 to US\$705.3 million for the six months ended June 30, 2008, primarily as a result of the company s exit from the DRAM commodity business and transition to increased capacity for logic production. The number of wafers the Company shipped decreased by 4.2%, from 894,038 8-inch wafer equivalents to 856,373 8-inch wafer equivalents, between these two periods. The simplified average selling price of total revenue during this period decreased by 3.5% from US\$854 per wafer to US\$824 per wafer.

Nevertheless, the Company s non-DRAM business continues to grow strongly. Non-DRAM revenue increased by 24.8% from US\$520.3 million for the six months ended June 30, 2007 to US\$649.3 million for the six months ended June 30, 2008, primarily from logic revenue associated with 0.35, 0.18 and 0.13 micron process technologies.

Cost of sales and gross profit (loss)

Cost of sales increased by 4.3% from US\$687.6 million for the six months ended June 30, 2007 to US\$717 million for the six months ended June 30, 2008. This increase was primarily due to a US\$28.7 million additional loss provision taken against the remaining DRAM inventories.

The Company had a gross loss of US\$11.7 million for the six months ended June 30, 2008 compared to a gross profit of US\$75.4 million for the six months ended June 30, 2007. Gross margins decreased to -2% for the six months ended June 30, 2007. The decrease in gross margin was primarily due to losses from the exit of the commodity DRAM business and a resulting higher unit cost due to reduced loading in the Beijing Fab.

Operating income, expenses and loss from operations

Operating expenses increased by 30.3% from US\$97.3 million for the six months ended June 30, 2007 to US\$126.8 million for the six months ended June 30, 2008 (excluding the income from the disposal of properties and the \$105.8 million impairment loss) primarily due to an increase in R&D expenses.

Research and development expenses increased by 60.1% from US\$44.9 million for the six months ended June 30, 2007 to US\$71.9 million for the six months ended June 30, 2008 primarily due to start up costs associated with the new 12-inch project in Shanghai.

Selling and marketing expenses increased by 13.7% from US\$8.1 million for the six months ended June 30, 2007 to US\$9.2 million for the six months ended June 30, 2008, primarily due to an increase in personnel related expenses associated with sales activities.



General and administrative expenses remained relatively flat at US\$31.9 million for the six months ended June 30, 2008, a slight 0.3% increase from US\$31.8 million for the six months ended June 30, 2007.

An asset impairment loss of \$105.8 million was recorded in Q1 2008 relating to the Beijing facility as a result of the decision to exit the commodity DRAM business.

Income from the disposal of properties decreased from US\$28.5 million for the six months ended June 30, 2007 to US\$1.6 million for the six months ended June 30, 2008.

The Company s operating loss was US\$242.6 million for the six months ended June 30, 2008 compared to operating gain of US\$6.6 million for the six months ended June 30, 2007.

The Company s operating margin was (34.4)% for the six months ended June 30, 2008 and 0.9% for the six months ended June 30, 2007.

Other income (expenses)

Other expenses increased by 44.0% from US\$6.1 million for the six months ended June 30, 2007 to US\$8.8 million for the six months ended June 30, 2008. This increase was primarily attributable to the increase in interest expense from US\$11.7 million for the six months ended June 30, 2007 to US\$32.5 million for the six months ended June 30, 2008. The increase in interest expense was primarily due to a decrease in government subsidy. However, interest income increased by 40.6%, from US\$5.6 million for the six months ended June 30, 2007 to US\$7.8 million for the six months ended June 30, 2008. Also, foreign exchange increased to a gain of US\$12.8 million for the six months ended June 30, 2008 from a loss of US\$1.1 million for the six months ended June 30, 2007.

The Company s net foreign exchange gain and loss, including operating, financing, and investing activities, was a gain of US\$16.5 million for the six months ended June 30, 2008 compared to a gain of US\$2.5 million for the six months ended June 30, 2007.

Net income (loss)

Due to the factors described above, the Company had a net loss of US\$270.5 million for the six months ended June 30, 2008 compared to a net gain of US\$6.7 million for the six months ended June 30, 2007.

Liquidity and Capital Resources

The Company incurred capital expenditures of US\$460.9 million for the six months ended June 30, 2007 and US\$367 million for the six months ended June 30, 2008. The Company has financed substantial capital expenditure requirements through the proceeds received from the cash flows from operations and bank borrowings. As of June 30, 2008, the Company had US\$480.3 million in cash and cash equivalents. These cash and cash equivalents are held in the form of United States Dollars, Japanese Yen, European Euro, and Chinese Renminbi. The net cash provided by operating activities decreased by 15.1% from US\$333.7 million for the six months ended June 30, 2007 to US\$283.4 million for the six months ended June 30, 2008.

The Company s net cash used in investing activities was US\$473.8 million for the six months ended June 30, 2008, primarily attributable to purchases of plant and equipment for the Mega Fab in Shanghai, Mega Fab in Beijing, Fab 7 and Fab 8 as well as costs associated with the construction of Fab 8. Net cash used in investing activities was US\$324.1 million for the six months ended June 30, 2007, primarily attributable to purchases of plant and equipment for the Mega Fab in Shanghai, Mega Fab in Beijing, Fab 7, and Fab 8 as well as costs associated with the construction of Fab 8.

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The Company s net cash used in financing activities was US\$201.5 million for the six months ended June 30, 2008. This was primarily derived from US\$280.5 million in proceeds from short-term borrowings, US\$250.7 million in proceeds from long-term debt, US\$15.0 million in the repayment of promissory notes, US\$144.5 million in the repayment of short-term borrowings, and US\$170.8 million in the repayment of long-term debt.

The Company s net cash used in financing activities was US\$0.7 million for the six months ended June 30, 2007. This was primarily due to repayment of US\$70 million in short-term borrowings, repayment of US\$25.3 million in long-term debt borrowings, repayment of US\$15.0 million in promissory notes, and proceeds of US\$107 million from short-term borrowings.

As of June 30, 2008, the Company s outstanding long-term liabilities primarily consisted of US\$1,036.9 million in secured bank loans, of which US\$341.6 million is classified as the current portion of long-term loans. The long-term loans are repayable in installments commencing in December 2006 with the last payments due in August 2012. *Long-term debt.* In June 2006, Semiconductor Manufacturing International (Shanghai) Corporation (SMIC Shanghai) entered into a new USD denominated long-term facility arrangement for US\$600.0 million with a consortium of international and PRC banks. Of this principal amount, US\$392.6 million was used to repay the principal amount outstanding under SMIC Shanghai s bank facilities from December 2001 and January 2004. The remaining principal amount will be used to finance future expansion and general corporate requirement for SMIC Shanghai. The Company has guaranteed SMIC Shanghai s obligations under this facility. As of June 30, 2008, SMIC Shanghai had fully drawn down US\$600.0 million on this loan facility. The Company has repaid US\$270.0 million and the remaining balance of US\$330.0 million was outstanding as of June 30, 2008. The interest rate on this loan facility ranged from 3.7% to 5.8% for the six months ended June 30, 2008. The interest expense incurred for the six months ended June 30, 2008 and 2007 was US\$9.2 million and US\$8.8 million, respectively, of which interest expense of 2007 was fully offset by the government subsidy granted in the period and US\$2.7 million was capitalized as additions to assets under construction for the six months ended June 30, 2008.

The key financial covenants contained in the loan agreement entered into in June 2006 include the following: Any of the following in respect of SMIC Shanghai would constitute an event of default during the term of the loan agreement (unless otherwise waived by the lenders to such agreement):

Consolidated tangible net worth of less than US\$1.2 billion;

The percentage of consolidated total borrowings to consolidated tangible net worth of more than 60% for periods up to and including December 31, 2008 and exceeds 45% thereafter;

The ratio of consolidated total borrowings to EBITDA for the prior four quarters exceeds 1.50x; or The debt service coverage ratio is less than 1.50x, where the debt service coverage ratio is the ratio of EBITDA for the previous four quarters divided by scheduled principal repayments and interest expense for

all bank borrowings (including hire purchases, leases and other borrowed monies) for the same period. Any of the following in respect of the Company would constitute an event of default during the term of the loan agreement (unless otherwise waived by the lenders to such agreement):

Consolidated tangible net worth of less than US\$2.3 billion;

The percentage of consolidated net borrowings to consolidated tangible net worth of more than 50% for periods up to and including June 30, 2009 and exceeds 40% thereafter; or

The ratio of consolidated net borrowings to EBITDA for the prior four quarters exceeds 1.50x for periods up to and including June 30, 2009 and exceeds 1.3x thereafter.

As of June 30, 2008, SMIC Shanghai had met these covenants such that no event of default had been triggered. In May 2005, Semiconductor Manufacturing International (Beijing) Corporation (SMIC Beijing) entered into a five year USD denominated loan facility in the aggregate principal amount of US\$600.0 million, with a syndicate of financial institutions based in the PRC. This five-year bank loan will be used to expand the capacity of SMIC Beijing s fabs. The drawdown period of this facility was twelve months from the sign off date of the agreement. As of June 30, 2008, SMIC Beijing had fully drawn-down US\$600.0 million on this loan facility. The interest rate on this loan facility ranged from 4.8% to 6.4% for the six months ended June 30, 2008. The principal amount is repayable starting in December 2007 in six semi-annual installments. As of June 30, 2008, SMIC Beijing had repaid US\$200.0 million and the remaining balance of US\$400.0 million was outstanding as of June 30, 2008. The interest expense incurred for the six months ended June 30, 2008 was US\$15.9 million, of which US\$1.2 million was capitalized as additions to assets under construction. The interest expense incurred for the six months ended June 30, 2007 in the amount of US\$21.0 million was partially offset by the government subsidy granted in the period and US\$0.1 million was capitalized as additions to assets under construction for the six months ended June 30, 2007.

Any of the following would constitute an event of default for SMIC Beijing during the term of the facility (unless otherwise waived by the lenders to such agreement):

[Net profit + depreciation + amortization + financial expenses (increase of accounts receivable and advanced payments + increase of inventory increase in accounts payable and advanced receipts)]/ financial expenses < 1; and

(Total liability borrowings from shareholders, including principal and interest)/Total assets > 60% (when SMIC Beijing s capacity is less than 20,000 12-inch wafers per month); and (Total liability borrowings from shareholders, including principal and interest)/Total assets > 50% (when SMIC Beijing s capacity exceeds 20,000 12-inch wafers per month).

As of June 30, 2008, SMIC Beijing had met these covenants.

On December 15, 2005, the Company entered into a EUR denominated long-term loan facility agreement in the aggregate principal amount of EUR 85 million (equivalent to approximately US\$105 million) with a syndicate of banks and ABN Amro Bank N.V. and Commerz Bank (Nederland) N.V. as the leading bank. The drawdown period of the facility ends on the earlier of (i) twenty six months after the execution of the agreement or (ii) the date which the loans have been fully drawn down. Each draw down made under the facility shall be repaid in full by us in ten equal semi-annual installments.

As of June 30, 2008, Semiconductor Manufacturing International (Tianjin) Corporation (SMIC Tianjin) had drawn down EUR 15.1 million and repaid an aggregated amount of EUR 7.5 million. As of June 30, 2008, the remaining balance is EUR 7.6 million, with the U.S. dollar equivalent of US\$12.0 million. The interest rate on this loan facility ranged from 4.7% to 5.9% for the six months ended June 30, 2008. The interest expense incurred for the six months ended June 30, 2008 and 2007 were US\$0.4 and US\$0.3 million of which US\$0.05 million and US\$0.1 million was capitalized additions to assets under construction for the six months ended June 30, 2008 and 2007, respectively. As of June 30, 2008, SMIC Shanghai had drawdown EUR 28.4 million and repaid an aggregated amount of EUR 5.7 million. As of June 30, 2008, the remaining balance is EUR 22.7 million, with the US dollar equivalent of US\$35.9 million. The interest rate on this loan facility ranged from 4.6% to 4.9% for the six months ended June 30, 2008. The interest expense for the six months ended June 30, 2008 was US\$0.9 million of which US\$0.3 million was capitalized additions to assets under construction for the six months ended June 30, 2008 and 2007, respectively.

In May 2006, SMIC Tianjin entered into a loan facility in the aggregate principal amount of US\$300.0 million with a consortium of international and Chinese banks. This facility is secured by the manufacturing equipment located in our Tianjin fab, except for the manufacturing equipment purchased using the EUR denominated loan, and our land use rights and plant in proportion to the principal amount outstanding under this facility and the EUR denominated loan. The Company has guaranteed SMIC Tianjin s obligations under this facility. As of June 30, 2008, SMIC Tianjin had drawn down US\$259.0 million on this loan facility. The principal amount is repayable starting from 2010 in six semi-annual installments. The interest rate on the loan ranged from 4.1% to 6.0% for the six months ended June 30, 2008. The interest expense incurred for the six months ended June 30, 2008 was US\$2.4 million, of which US\$0.56 million was capitalized as additions to assets under construction for the six months ended June 30, 2008. Any of the following in respect of SMIC Tianjin would constitute an event of default during the term of the facility (unless otherwise waived by the lenders to such agreement):

[Net profit + depreciation + amortization + financial expenses (increase of accounts receivable and advanced payments + increase of inventory increase in accounts payable and advanced receipts)] / financial expenses < 1; and

The ratio of total debt to total assets is more than 60% during the ramp up period of SMIC Tianjin and more than 40% after the facility is at full capacity.

As of June 30, 2008, SMIC Tianjin had met these covenants.

Short-term borrowings. As of June 30, 2008, the Company had short-term credit agreements that provided total credit facilities up to approximately US\$446 million on a revolving credit basis. As of June 30, 2008, the Company had drawn down approximately US\$243 million under these credit agreements and approximately US\$203 million is available for future borrowings. The outstanding borrowings under the credit agreements are unsecured, except for the amount of US\$87 million, which is secured by term deposits. The interest expense incurred for the six months ended June 30, 2008 and 2007 were US\$3.0 million and US\$1.9 million, respectively. The interest rate on the loans ranged from 3.3% to 7.3% for the six months ended June 30, 2008.

Capitalized Interest

Interest cost incurred on funds used to construct plant and equipment during the active construction period is capitalized, net of government subsidies received. The interest capitalized is determined by applying the borrowing interest rate to the average amount of accumulated capital expenditures for the assets under construction during the period. Capitalized interest is added to the cost of the underlying assets and is amortized over the useful life of the assets. Capitalized interest of US\$4.7 million and US\$0.6 million have been added to the cost of the underlying assets during the six months ended June 30, 2008 and June 30, 2007, respectively, and is amortized over the respective useful life of the assets. For the six months ended June 30, 2008 and June 30, 2008 and June 30, 2007, the Company recorded amortization expenses relating to the capitalized interest of US\$3.4 million and US\$2.6 million, respectively.

Commitments

As of June 30, 2008, the Company had commitments of US\$75.6 million for construction obligations for the Beijing, Tianjin, Shanghai, Energy Technology and Chengdu facilities, and US\$369.4 million to purchase machinery and equipment for the Beijing, Tianjin, Shanghai, Energy Technology, Cayman and Chengdu facilities.

Debt to Equity Ratio

As of June 30, 2008, the Company s debt to equity ratio was 46% calculated by dividing the sum of the short-term borrowings, current portion of long-term debt and long-term debt by total shareholders equity.

Contingent Liabilities

As of June 30, 2008, the Company did not have any material contingent liabilities.

Foreign Exchange Rate Fluctuation Risk

The Company s revenues, expenses, and capital expenditure are primarily transacted in United States Dollars. However, since the Company has operations consisting of manufacturing, sales activities and capital purchasing outside of the U.S., the Company enters into transactions in other currencies and is primarily exposed to changes in exchange rates for the EURO, Japanese Yen, and Chinese Renminbi.

To minimize these risks, the Company purchases foreign-currency forward exchange contracts with contract terms normally lasting less than twelve months to protect against the adverse effect that exchange rate fluctuations may have on foreign currency denominated activities. These forward exchange contracts are principally denominated in Chinese Renminbi, Japanese Yen or EURO and do not qualify for hedge accounting in accordance with SFAS No. 133. As of June 30, 2008, the Company had outstanding foreign currency forward exchange contracts with a notional amount of US\$68.3 million all of which matured in June 2009. Notional amounts are stated in U.S. dollar equivalent spot market exchange rates, as of the respective dates.

As of June 30, 2008, the fair value of foreign currency forward exchange contracts was a loss of approximately US\$2.3 million, which is recorded in accrued expenses and other current liabilities. The Company does not enter into foreign currency exchange contracts for speculative purposes.

Interest Rate Risk

The Company s exposure to interest rate risks relates primarily to the Company s long-term debt obligations, which the Company generally assumes to fund capital expenditures and working capital requirements. The Company s long-term debt obligations are all subject to variable interest rates. The interest rates on the Company s U.S. dollar-denominated loans are linked to the LIBOR. The interest on the Company s EURO denominated loans are linked to the EURIBOR. As a result, the interest on the Company s loans are subject to fluctuations in the underlying interest rates to which they are linked.

Cross Currency Swap Fluctuation Risk

On December 15, 2005, the Company entered into a long-term loan facility agreement in the aggregate principal amount of EUR85 million. The company is primarily exposed to changes in exchange rate for the EURO. To minimize the risk, the company entered into a cross currency swap contract with contract terms fully matching the repayment schedule of the long-term loan to protect against the adverse effect of exchange rate fluctuations arising from the foreign-currency denominated loan. The cross currency swap contract does not qualify for hedge accounting in accordance with SFAS No. 133.



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Litigation

On August 25, 2006, TSMC filed a lawsuit against the Company and certain subsidiaries (SMIC (Shanghai), SMIC (Beijing) and SMIC (Americas)) in the Superior Court of the State of California, County of Alameda for alleged breach of the Settlement Agreement, alleged breach of promissory notes and alleged trade secret misappropriation by the Company. TSMC seeks, among other things, damages, injunctive relief, attorneys fees, and the acceleration of the remaining payments outstanding under the Settlement Agreement.

In the present litigation, TSMC alleges that the Company has incorporated TSMC trade secrets in the manufacture of the Company s 0.13 micron or smaller process products. TSMC further alleges that as a result of this claimed breach, TSMC s patent license is terminated and the covenant not to sue is no longer in effect with respect to the Company s larger process products.

The Company has vigorously denied all allegations of misappropriation. The Court has made no finding that TSMC s claims are valid, nor has it set a trial date.

On September 13, 2006, the Company announced that in addition to filing a response strongly denying the allegations of TSMC in the United States lawsuit, it filed on September 12, 2006, a cross-complaint against TSMC seeking, among other things, damages for TSMC s breach of contract and breach of implied covenant of good faith and fair dealing.

On November 16, 2006, the High Court in Beijing, the People s Republic of China, accepted the filing of a complaint by the Company and its wholly-owned subsidiaries, SMIC (Shanghai) and SMIC (Beijing), regarding the unfair competition arising from the breach of bona fide (i.e. integrity, good faith) principle and commercial defamation by TSMC (PRC Complaint). In the PRC Complaint, the Company is seeking, among other things, an injunction to stop TSMC s infringing acts, public apology from TSMC to the Company and compensation from TSMC to the Company, including profits gained by TSMC from their infringing acts.

TSMC filed with the California court in January 2007 a motion seeking to enjoin the PRC action. In February 2007, TSMC filed with the Beijing High Court a jurisdictional objection, challenging the competency of the Beijing High Court s jurisdiction over the PRC action.

In March 2007, the California Court denied TSMC s motion to enjoin the PRC action. TSMC appealed this ruling to California Court of Appeal. On March 26, 2008, the Court of Appeal, in a written opinion, denied TSMC s appeal. In July 2007, the Beijing High Court denied TSMC s jurisdictional objection and issued a court order holding that the Beijing High Court shall have proper jurisdiction to try the PRC action. TSMC appealed this order to the Supreme Court of the People s Republic of China. On January 7, 2008, the Supreme Court heard TSMC s appeal. On June 13, 2008, the Supreme Court denied TSMC s appeal and affirmed the jurisdiction of the Beijing High Court. On August 14, 2007, the Company filed an amended cross-complaint against TSMC seeking, among other things, damages for TSMC s breach of contract and breach of patent license agreement. TSMC thereafter denied the allegations of the Company s amended cross-complaint and subsequently filed additional claims that the Company

breached the Settlement Agreement by filing an action in the Beijing High Court. The Company has denied these additional claims by TSMC.

On August 15-17, 2007, the California Court held a preliminary injunction hearing on TSMC s motion to enjoin use of certain process recipes in certain of the Company s 0.13 micron logic process flows. On September 7, 2007, the Court denied TSMC s preliminary injunction motion, thereby leaving unaffected the Company s development and sales. However, the court required the Company to provide 10 days advance notice to TSMC if the Company plans to disclose logic technology to non-SMIC entities under certain circumstances, to allow TSMC to object to the planned disclosure.

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On March 11, 2008, TSMC filed an application for a right to attach order in the California Court. By its application, TSMC sought an order securing an amount equal to the remaining balance on the promissory notes issued by the Company in connection with the Settlement Agreement. The Company opposed the application. A hearing was held on April 3, 2008. On June 24, 2008, the Court denied TSMC sapplication.

In May 2008, TSMC filed a motion in the California Court for summary adjudication against the Company on several of the Company s cross claims. The Company opposed the motion and on July 25, 2008, the Court granted in part and denied in part TSMC s motion.

On June 23, 2008, the Company filed with California court a cross-complaint against TSMC seeking, among other things, damages for TSMC sunlawful misappropriation of trade secrets from SMIC to improve its competitive position against SMIC.

On July 10, 2008, the California Court held and granted part of a preliminary injunction hearing on TSMC s motion to enjoin disclosure of information on certain process recipes in the Company s 0.30 micron logic process flows to third parties.

Under the provisions of SFAS 144, the Company is required to make a determination as to whether or not this pending litigation represents an event that requires a further analysis of whether the patent license portfolio has been impaired. We believe that the lawsuit is at a preliminary stage and we are still evaluating whether or not the litigation represents such an event. The Company expects further information to become available to us which will aid us in making a determination. The outcome of any impairment analysis performed under SFAS 144 might result in a material impact to our financial position and results of operations. Because the case is in its preliminary stages, the Company is unable to evaluate the likelihood of an unfavorable outcome or to estimate the amount or range of potential loss.

Employees

Save as disclosed in this interim report, there is no material change to the information disclosed in the 2007 annual report of the Company in relation to the number and remuneration of employees, remuneration policies, bonus and share option schemes of employees.

Prospects and Future Plan

In the second half of 2008, the Company will continue its strategic execution on several fronts. First and foremost, the Company aims to continue the conversion efforts of DRAM to Logic production in the Beijing facility. By leveraging existing Logic expertise, the conversion will further expand the Company service scale and create better positioning to meet customer demands. In addition, the Company will continue its efforts in developing advanced technology capabilities to meet customer needs. Enhancing resources to better service the current and future customer base still remains a top priority.

Corporate Governance Report

The Company is committed to remaining an exemplary corporate citizen and maintaining a high level of corporate governance in order to protect the interests of its shareholders.

CORPORATE GOVERNANCE PRACTICES

The SEHK s Code on Corporate Governance Practices (the CG Code) as set out in Appendix 14 of the Rules Governing the Listing of Securities on the SEHK (Listing Rules), which contains code provisions to which an issuer such as the Company, is expected to comply or advise as to reasons for deviations (the Code Provisions) and recommended best practices with which an issuer is encouraged to comply (the Recommended Practices). At the meeting of the Board on January 25, 2005, the Board approved the Corporate Governance Policy (the CG Policy) (which was amended by the Board on July 26, 2005) with effect from such date. The updated CG Policy, a copy of which can be obtained on the Company s website at www.smics.com under Corporate Governance , incorporates all of the code provisions of the CG Code and many of the Recommended Practices.

In addition, the Company has adopted or put in place various policies, procedures, and practices in compliance with the provision of the CG Policy. None of the Directors are aware of any information which would reasonably indicate that the Company is not, or was not, during the financial period from January 1, 2008 to June 30, 2008, in compliance with the CG Policy.

MODEL CODE FOR SECURITIES TRANSACTIONS BY DIRECTORS OF LISTED ISSUERS

The Company has adopted an Insider Trading Compliance Program (the Insider Trading Policy), which encompasses the requirements of the Model Code as set out in Appendix 10 of the Listing Rules. The Company, having made specific enquiry of all directors, confirms that all members of the Board have complied with the Insider Trading Policy and the Model Code throughout the six months ended June 30, 2008. The senior management as well as all officers, directors, and employees of the Company and its subsidiaries are also required to comply with the provisions of the Insider Trading Policy.

The Board

The Board has a duty to the Company s shareholders to direct and oversee the affairs of the Company in order to maximize shareholder value. The Board acting itself and through the various committees of the Board, actively participates in the determination of the overall strategy of the Company, the establishment and monitoring of the achievements of corporate goals and objectives, the oversight of the Company s financial performance, the establishment of corporate governance practices and policies, and the review of the Company s system of internal controls. The management of the Company is responsible for the implementation of the overall strategy of the Company and its daily operations and administration. The Board has access to the senior management of the Company to discuss enquiries on management information.

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The Board consists of eight directors as at the date of the interim report. Directors may be elected to hold office until the expiration of their respective terms upon a resolution passed at a duly convened shareholders meeting by holders of a majority of the Company s outstanding shares being entitled to vote in person or by proxy at such meeting. The Board is divided into three classes with no more than one class eligible for re-election at any annual general meeting of shareholders.

Each class of director will serve terms of three years. The Class I directors were elected for a term of three years at the Company s 2008 Annual General Meeting (2008 AGM) of the shareholders of the Company (except Dr. Albert Y. C. Yu who retired at the 2008 AGM). The Class II directors were elected at the 2006 Annual General Meeting of the shareholders of the Company for a term of three years. The Class III directors were elected at the 2007 Annual General Meeting of the Shareholders of the Shareholders of the Company for a term of three years.

For the six months ended June 30, 2008, the Board at all times exceeded the minimum requirements of the Listing Rules relating to the appointment of at least three independent non-executive directors on the board, and complied with the requirement that these should include one such director with appropriate professional qualifications or accounting or related financial management expertise. The roles of the chairman and chief executive officer are segregated and such roles are exercised by Prof. Yang Yuan Wang and Dr. Richard Ru Gin Chang respectively. At the 2008 AGM, Richard Ru Gin Chang and Henry Shaw were re-elected as Class I executive director and independent non-executive director of the Company respectively and Albert Y. C. Yu retired as a Class I independent non-executive director and did not offer himself for re-election.

Wang Zheng Gang was re-elected at the 2008 Annual General Meeting of the shareholders of the Company as a Class III non-executive director of the Company.

The following table sets forth the names, classes and categories of the directors as at the date of this report:

Name of DirectorCategory of Director		Class of Director
Yang Yuan Wang	Chairman, Independent Non-executive Director	Class III
Richard Ru Gin Chang	President, Chief Executive Officer, Executive Director	Class I
Henry Shaw	Independent Non-executive Director	Class I
Ta-Lin Hsu	Independent Non-executive Director	Class II
Jiang Shang Zhou	Independent Non-executive Director	Class II
Lip-Bu Tan	Independent Non-executive Director	Class II
Tsuyoshi Kawanishi	Independent Non-executive Director	Class III
Wang Zheng Gang	Non-executive Director	Class III

On an annual basis, each independent non-executive director confirms his independence to the Company, and the Company considers these directors to be independent as such term is defined in the Listing Rules. There are no relationships among members of the Board, including between the Chairman of the Board and the Chief Executive Officer.

The Board meets in person at least on a quarterly basis and on such other occasions as may be required to discuss and vote upon significant issues affecting the Company. The regular Board meeting schedule for a year is planned in the preceding year. The Company Secretary assists the Chairman in preparing the agenda for meetings and the Board in complying with relevant rules and regulations. The relevant papers for the Board meetings are dispatched to the Board members in accordance with the CG code. Directors may include matters for discussion in the agenda if the need arises. Upon the conclusion of the Board meeting, minutes are circulated to all directors for their comment and review prior to their approval of the minutes at the following or a subsequent Board meeting. Transactions in which directors are considered to have a conflict of interest or material interests are not passed by written resolutions and the interested directors are not counted in the quorum and abstain from voting on the relevant matters.

All directors have access to the Company Secretary who is responsible for assisting the Board in complying with applicable procedures regarding compliance matters. Every Board member is entitled to have access to documents provided at the Board meeting or filed into the Company s minute-book. Furthermore, the Board has established the procedures pursuant to which a director, upon reasonable request, may seek independent professional advice at the Company s expense in order for such director to exercise such director s duties. The Company Secretary continuously updates all directors on the latest development of the Listing Rules and other applicable regulatory requirements to assist the Company s compliance with and maintenance of good corporate governance practices. Each new director is provided with training with respect to such director s responsibilities under the Listing Rules and other regulatory requirements and the Company s corporate governance policies and practices.

BOARD COMMITTEES

The Board has established the following committees to assist it in exercising its obligations. These committees consist of only independent non-executive directors who have been invited to serve as members. The committees are governed by their respective charters setting out clear terms of reference.

Audit Committee

As of June 30, 2008, the members of the Audit Committee were Henry Shaw (co-chairman of Audit Committee), Lip-Bu Tan (co-chairman of Audit Committee) and Yang Yuan Wang. None of these members of the Audit Committee have been an executive officer or employee of the Company or any of its subsidiaries. In addition to acting as Audit Committee member of the Company, Mr. Lip-Bu Tan, one of the members of the Audit Committee, currently also serves on the audit committee of three other publicly traded companies, namely SINA Corporation, Flextronics International Ltd. and Integrated Silicon Solution, Inc. In general and in accordance with section 303A.07(a) of the Listed Company Manual of the New York Stock Exchange, the Board considered and determined that such simultaneous service would not impair the ability of Mr. Tan to effectively serve on the Company 's Audit Committee. The responsibilities of the Audit Committee include, among other things:

- making recommendations to the Board concerning the appointment, reappointment, retention, evaluation, oversight and termination of the work of the Company s independent auditor, including reviewing the experience, qualifications and performance of the senior members of the independent auditor team and pre-approving all non-audit services to be provided by the Company s independent auditor;
- approving the remuneration and terms of engagement of the Company s independent auditor;
- reviewing reports from the Company s independent auditor regarding its internal quality-control procedures and any material issues raised in the most recent review or investigation of such procedures and regarding all relationships between the Company and the independent auditor;
- pre-approving the hiring of any employee or former employee of the Company s independent auditor who was a member of the audit team during the preceding two years;
- reviewing the Company s annual and interim financial statements, earnings releases, critical accounting policies and practices used to prepare financial statements, alternative treatments of financial information, the
- effectiveness of the Company s disclosure controls and procedures and important trends and developments in financial reporting practices and requirements;
- reviewing the planning and staffing of internal audits, the organization, responsibilities, plans, results, budget and staffing of the Company s Internal Audit Department (as defined and discussed below) and the quality and effectiveness of the Company s internal controls;
- reviewing the Company s risk assessment and management policies;

reviewing any legal matters that may have a material impact and the adequacy and effectiveness of the Company s legal and regulatory compliance procedures;

establishing procedures for the treatment of complaints received by the Company regarding accounting, internal accounting controls, auditing matters, potential violations of law and questionable accounting or auditing matters; and

obtaining and reviewing reports from management, the Company s internal auditor and the Company s independent auditor regarding compliance with applicable legal and regulatory requirements.

The Audit Committee reports its work, findings and recommendations to the Board during each quarterly meeting. The Audit Committee meets in person at least on a quarterly basis and on such other occasions as may be required to discuss and vote upon significant issues affecting the audit policy of the Company. The regular meeting schedule for a year is planned in the preceding year. The Company Secretary assists the co-chairmen of the Audit Committee in preparing the agenda for meetings and assists the Audit Committee in complying with the relevant rules and regulations. The relevant papers for the Audit Committee meetings are dispatched to the Audit Committee members in accordance with the CG Code. Members of the Audit Committee may include matters for discussion in the agenda if the need arises. Upon the conclusion of the Audit Committee meeting, minutes are circulated to the members of the Audit Committee for their comment and review prior to their approval of the minutes at the following or a subsequent Audit Committee meeting.

At each quarterly Audit Committee meeting, the Audit Committee reviews with the Acting Chief Financial Officer and the Company s outside auditors, the financial statements for the financial period and the financial accounting principles, policies and controls of the Company and its subsidiaries. In particular, the Committee discusses (i) the changes in accounting policies and practices, if any; (ii) the going concern assumptions, (iii) compliance with accounting standards and applicable rules and other legal requirements in relation to financial reporting and (iv) the internal controls of the Company relating to financial reporting. Upon the recommendation of the Audit Committee, the Board will approve the financial statements.

Compensation Committee

As of June 30, 2008, the members of the Company s Compensation Committee were Ta-Lin Hsu (chairman of Compensation Committee), Tsuyoshi Kawanishi and Lip-Bu Tan. None of these members of the Compensation Committee has been an executive officer or employee of the Company or any of its subsidiaries.

The responsibilities of the Compensation Committee include, among other things:

approving and overseeing the total compensation package for the Company s executive officers/senior management (namely, the same category of persons referred to, and required to be disclosed, in the Company s annual report), evaluating the performance of and determining and approving the compensation to be paid to the Company s Chief Executive Officer and reviewing the results of the Chief Executive Officer s evaluation of the performance of the Company s other executive officers;

reviewing and making recommendations to the Board with respect to Director compensation, including equity-based compensation;

administering and periodically reviewing and making recommendations to the Board regarding the long-term incentive compensation or equity plans made available to the Directors, employees and consultants;

reviewing and making recommendations to the Board regarding executive compensation philosophy, strategy and principles and reviewing new and existing employment, consulting, retirement and severance agreements proposed for the Company s executive officers; and

ensuring appropriate oversight of the Company s human resources policies and reviewing strategies established to fulfill the Company s ethical, legal and human resources responsibilities.

The Compensation Committee reports its work, findings and recommendations to the Board during each quarterly Board meeting.

The Compensation Committee meets in person at least on a quarterly basis and on such other occasions as may be required to discuss and vote upon significant issues affecting the compensation policy of the Company. The regular meeting schedule for a year is planned in the preceding year. The Company Secretary assists the chairman of the Compensation Committee in preparing the agenda for meetings and assists the Compensation Committee in complying with relevant rules and regulations. The relevant papers for the Compensation Committee meeting are dispatched to Compensation Committee members in accordance with the CG Code. Members of the Compensation Committee meeting, minutes are circulated to the members of the Compensation Committee for their compensation Committee meeting, minutes are circulated to the members of the Compensation Committee for their comment and review prior to their approval of the minutes at the following or a subsequent Compensation Committee meeting.

Internal Audit Department

The internal audit department works with and supports the Company s management team and the Audit Committee in monitoring the Company s compliance with its internal governance policies. On a regular basis, the internal audit department audits the practices, procedures, expenditure and internal controls of the various departments in the Company. After completing an audit, the internal audit department furnishes the Company s management team and the Audit Committee with analyses, appraisals, recommendations, counsel, and information concerning the activities reviewed. The internal audit department can also conduct reviews and investigations on an ad hoc basis. Code of Business Conduct and Ethics

The Board has adopted a code of business conduct and ethics (the Code of Conduct) which provides guidance about doing business with integrity and professionalism. The Code of Conduct addresses issues including, among others, fraud, conflicts of interest, corporate opportunities, protection of intellectual property, transactions in the Company s securities, use of the Company s assets, and relationships with customers and third parties. Any violation of the Code of Conduct is reported to the Compliance Office, which will subsequently report such violation to the Audit Committee.

U.S. Corporate Governance Practices

Companies listed on the NYSE must comply with certain corporate governance standards under Section 303A of the New York Stock Exchange Listed Company Manual. However, foreign private issuers such as the Company are permitted to follow home country practices in lieu of the provisions of Section 303A, except that such companies are required to comply with certain rules relating to the audit committee. Please refer to the following website at http://www.smics.com/website/enVersion/IR/corporateGovernance.htm for a summary of the significant differences between the Company s corporate governance practices and those required of U.S. companies under NYSE listing standards.

Other Information

1. Dividends

The Board of the Company proposed not to declare an interim dividend for the period of the six months ended June 30, 2008.

2. Share Capital

During the six months ended June 30, 2008, the Company issued 17,316,642 Ordinary Shares to certain of the Company s eligible participants including employees, directors, officers and service providers of the Company (eligible participants) pursuant to the Company s 2004 stock option plan (the Stock Option Plan) and 16,683,981 ordinary shares to certain of the eligible participants pursuant to the Company s 2004 equity incentive plan.

Number of Shares Outstanding

Outstanding Share Capital as of June 30, 2008

18,592,920,335

Under the terms of the Company s 2004 Equity Incentive Plan, the Compensation Committee may grant restricted share units (Restricted Share Units) to eligible participants. Each Restricted Share Unit represents the right to receive one Ordinary Share. Restricted Share Units granted to new employees generally vest at a rate of 10% upon the second anniversary of the vesting commencement date, an additional 20% on the third anniversary of the vesting commencement date, and an additional 70% upon the fourth anniversary of the vesting commencement date. Restricted Share Units granted to existing employees generally vest at a rate of 25% upon the first, second, third, and fourth anniversaries of the vesting commencement date. Upon vesting of the Restricted Share Units and subject to the terms of the Insider Trading Policy and the payment by the participants of applicable taxes, the Company will issue the relevant participants the number of Ordinary Shares underlying the awards of Restricted Share Units. For the twelve months ended December 31, 2004, the Compensation Committee granted a total of 118,190,824 Restricted Share Units pursuant to which the Company issued an aggregate of 18,536,451 ordinary shares to its eligible participants on or around July 1, 2005. For the twelve months ended December 31, 2005, the Compensation Committee granted a total of 122,418,740 Restricted Share Units pursuant to which the Company issued an aggregate of 27,591,342 ordinary shares to its eligible participants on or around January 1, 2006 and July 1, 2006. For the twelve months ended December 31, 2006, the Compensation Committee granted a total of 16,058,864 Restricted Share Units pursuant to which the Company issued an aggregate of 3,407,216 ordinary shares to its eligible participants on or around January 1, February 27, March 1, March 3, March 23, May 30, July 1, September 1, September 16, October 1 and October 16, 2007.



For the twelve months ended December 31, 2007, the Compensation Committee granted a total of 40,519,720 Restricted Share Units and for the six months ended June 30, 2008, the Compensation Committee granted a total of 39,827,100 Restricted Share Units. The remaining vesting dates of these Restricted Share Units (after deducting the number of Restricted Share Units granted but cancelled due to the departure of eligible participants prior to vesting) approximately are as follows:

Approximate Restricted Share Units (the actual number may change due to the departure of employees prior to vesting)

2008	
1-Jan	14,777,833
19-Jan	12,500
1-Feb	250,000
1-Mar	200,000
1-Mar	45,790
3-Mar	250,000
23-Mar	175,000
1-Apr	16,667
19-Apr	17,760
25-Apr	150,000
29-Apr	400,000
1-May	100,000
15-May	83,333
25-May	100,000
1-Jun	178,423
16-Jun	166,667
21-Jun	100,000
1-Jul	17,657,012
1-Aug	590,000
1-Sep	10,990,851
1-Sep	693,900
1-Sep	57,271
13-Sep	375,000
16-Sep	75,000
16-Sep	50,000
1-Oct	727,500
1-Oct	96,563
16-Oct	72,216
16-Oct	150,000
1-Nov	250,000
1-Dec	101,930
1-Dec	75,000
6-Dec	100,000
12-Dec	75,000

Vesting Dates

Approximate Restricted Share Units (the actual number may change due to the departure of employees prior to vesting)

Vesting Dates

2009	
1-Jan	23,930,096
19-Jan	12,500
1-Feb	250,000
1-Mar	200,000
1-Mar	45,790
3-Mar	250,000
23-Mar	175,000
1-Apr	16,667
19-Âpr	17,760
1-May	100,000
15-May	83,333
25-May	100,000
1-Jun	178,423
16-Jun	166,667
21-Jun	100,000
1-Jul	1,058,397
1-Aug	590,000
1-Sep	10,990,851
1-Sep	693,900
1-Sep	57,271
10-Sep	9,450
13-Sep	375,000
16-Sep	75,000
16-Sep	50,000
1-Oct	727,500
1-Oct	96,563
16-Oct	72,216
16-Oct	150,000
1-Nov	250,000
1-Dec	101,930
1-Dec	75,000
6-Dec	100,000
12-Dec	75,000

Approximate Restricted Share Units (the actual number may change due to the departure of employees prior to vesting)

Vesting Dates

2010	
1-Jan	23,930,096
10-Jan	8,750
19-Jan	12,500
1-Feb	250,000
1-Mar	200,000
1-Mar	45,790
3-Mar	250,000
23-Mar	175,000
1-Apr	16,667
19-Åpr	17,760
1-May	100,000
15-May	83,333
25-May	100,000
1-Jun	178,423
16-Jun	166,667
21-Jun	100,000
1-Jul	733,125
1-Sep	693,900
1-Sep	57,271
10-Sep	9,450
16-Sep	75,000
16-Sep	50,000
1-Oct	727,500
1-Oct	96,563
16-Oct	72,216
16-Oct	150,000
1-Nov	250,000
1-Dec	101,930
1-Dec	75,000
6-Dec	100,000
12-Dec	75,000

Approximate Restricted Share Units (the actual number may change due to the departure of employees prior to vesting)

Vesting Dates

2011	
1-Jan	10,092,846
10-Jan	8,750
19-Jan	12,500
1-Feb	250,000
1-Mar	45,790
1-Apr	16,667
19-Åpr	17,760
1-May	100,000
13-May	12,500
15-May	83,333
25-May	100,000
1-Jun	178,423
16-Jun	166,667
21-Jun	100,000
1-Jul	628,125
1-Sep	57,271
10-Sep	9,450
16-Sep	50,000
1-Oct	96,563
16-Oct	150,000
1-Nov	250,000
1-Dec	75,000
12-Dec	75,000
2012	
1-Jan	9,314,763
10-Jan	8,750
13-May	12,500
1-Jul	9,375
10-Sep	9,450
2013	
10-Jan	8,750

3. Substantial Shareholders Interest

Set out below are the names of the parties (not being a director or chief executive of the Company) which were interested in five percent or more of the nominal value of the share capital of the Company and the respective relevant numbers of shares in which they were interested as of June 30, 2008 as recorded in the register kept by the Company under section 336 of the Securities and Futures Ordinance (Cap.571 of the Laws of Hong Kong) (SFO).

Name of Shareholder	Number of Shares Held	Percentage Held
Shanghai Industrial	36,310,000 (long	0.20% (long
Investment (Holdings)	position)(1) 1,814,991,340 (long	position) 9.76% (long
Company Limited (SIIC)	position)(2)	position)
Total: Notes:	1,851,301,340 (long position)	9.96% (long position)

 All such ordinary shares are held by SIIC Treasury (B.V.I.) Limited which is a wholly-owned subsidiary of SIIC.

(2) All such

ordinary shares are held by S.I. Technology Production Holdings Limited (SITPHL) which is a wholly-owned subsidiary of Shanghai Industrial Holdings Limited (SIHL). SIHL is an indirect non-wholly owned subsidiary of

SIIC which holds SIHL s shares through its wholly-owned subsidiaries, namely, SIIC CM Development Limited, SIIC Capital (B.V.I.) Limited and Shanghai Investment Holdings Limited, which together are entitled to exercise or control the exercise of more than one-third of the voting power at the general meetings of SI HL. By virtue of the SFO, SIIC and its subsidiaries namely, Shanghai Investment Holdings Limited and Shanghai Industrial Investment Treasury Company Limited are deemed to be interested in the 1,814,991,340 Shares held by SITPHL. The Company s Director as of June 30, 2008, Wang Zheng Gang, is the

Chief Representative of the Shanghai Representative Office of SIHL and the chairman and general manager of SIIC Management (Shanghai) Limited. It is the Company s understanding that voting and investment control over the ordinary shares beneficially owned by SIHL are maintained by the board of directors of SIHL.

4. Shareholding Interests Of The Directors Of The Company

As of June 30, 2008, the interests or short positions of the directors in the Ordinary Shares, underlying shares and debentures of the Company (within the meaning of Part XV of the SFO, as recorded in the register required to be kept under section 352 of the SFO or as otherwise notified to the Company and SEHK pursuant to the Model Code) were as follows:

Board Member	Nature of Interest	Number of Shares	Percentage of Aggregate Interests to Total Issued Share Capital
	Personal Interest	35,579,550	1
Richard Ru Gin Chang	(1)		
	Personal Interest (2)(6)	17,600,000	
	Corporate Interest (3)	20,000,000	
	Interest of Spouse	9,790,000	
	Interest of Child under 18	11,200,000	
Total		94,169,550	*
Ta-Lin Hsu	Corporate Interest (4)	15,300,010	
	Personal Interest (5)(6)	1,000,000	
Total		16,300,010	*
Tsuyoshi Kawanishi	Personal Interest (5)(6)	1,000,000	
	Personal Interest (7)	1,500,000	
Total		2,500,000	*
Henry Shaw	Personal Interest (5)(6)	1,000,000	*
-	Personal Interest	1,000,000	*
Lip-Bu Tan	(5)(6) Personal Interest	1,000,000	*
Yang Yuan Wang	(5)(6)		
Albert Y. C. Yu	Personal Interest Personal Interest	1,350,000 1,000,000	*
	(6)(8)	1,000,000	
Total		2,350,000	*

* Indicates less than 1%.

Notes:

(1) Pursuant to a Charitable Pledge Agreement dated December 1. 2003, Richard Ru Gin Chang and his spouse, Scarlett K. Chang (collectively, the Donors) have pledged to transfer 10,000,000 of such ordinary shares as a charitable gift to The Richard and Scarlett Chang Family Foundation, a Delaware nonprofit nonstock corporation organized exclusively for religious, charitable, scientific, literary and education purposes within the meaning of Section 501(c)(3)of the US Internal Revenue Code of 1986, as amended, such transfer to be made in full at or prior to the death of the surviving Donor. In addition, 2,639,550 of such ordinary shares are jointly held by Richard Ru Gin

Chang and his spouse, Scarlett K. Chang.

(2) The

Compensation Committee has granted Dr. Chang options to purchase an aggregate of 15,100,000 ordinary shares if fully exercised, and an award of 2,000,000 RSUs (each representing the right to receive one ordinary share). As of June 30, 2008, none of these options have been exercised and 75% of the RSUs have vested.

(3) These ordinary shares are held by

Jade Capital Company, LLC, a Delaware limited liability company (the LLC), of which Richard Ru Gin Chang and his spouse, Scarlett K. Chang (collectively, the Members), are the sole Members. It is the current intention of the Members that all or a portion of the net income of the LLC be used for philanthropic purposes, including but not

limited to contributions to charitable organizations that are tax-exempt under Section 501(c)(3)of the US Internal Revenue Code of 1986, as amended. (4) Ta-Lin Hsu has a controlling interest in AP3 **Co-Investment** Partners, LDC, which holds 15,300,010 ordinary shares. (5) Each independent Non-executive Director and Non-executive Director was granted an option to purchase 500,000 ordinary shares at a price per ordinary share of US\$0.22. These options were fully vested on March 19. 2005 and will expire on November 9, 2009. As of June 30, 2008, these options have not been exercised. Lai Xing Cai (who resigned as an Non-executive Director on February 6, 2006) has declined such option. The option granted to

Mr. Yen-Pong Jou (who retired as an Independent Non-executive Director at the annual general meeting held on May 30, 2006) lapsed and was cancelled on September 27, 2006. (6) Each Director was granted an option to purchase 500,000 ordinary shares at a price per ordinary share of US\$0.132. These options were fully vested on May 30, 2008 and will expire on the earlier of September 29, 2016 or 120 days after termination of the director s service to the Board. As of June 30, 2008, these options have not been exercised. Fang Yao (who resigned as non-executive director on

Zhou have declined such option.
(7) Tsuyoshi Kawanishi has been granted options to

August 30, 2007) and Jiang Shang

purchase an

aggregate of 1,500,000 ordinary shares, if fully exercised. As of June 30, 2008, these options have not been exercised.

(8) On September 29, 2006, the Board granted to Dr. Albert Y. C. Yu 500,000 **Restricted Share** Units. Shares under the **Restricted Share** Units are to be automatically vested as to 50% per year starting from May 30, 2007. As of June 30, 2008, all such Restricted Share Units have vested.

2001 Stock Option Plans

						Ont	ions		Weighted Average Closing Price of
						Lap			Shares
						D		i	mmediate
							0		
						Repu	rchase		before
						O	of		Dates on
			No. of	Exercise	e Options	OptionOrdi	naryOptions Opti	ons Options	which
Eligible		Period during which	Options	Price	Outstanding	-	aresExercisedance	-	g Options
	Date			Per	as of	U	ring During Dur	U	were
yees	Granted	Rights Exercisable	Granted	Share	12/31/07	PeriodPeri	od* Period Peri	od 06/30/08	Exercise
				(USD)					(USD)
yees	28/3/2001	3/28/2001 - 3/27/2011	89,385,000	\$0.01	4,756,500		40,000	4,716,500	\$ 0.09
vees	2/4/2001	4/02/2001 - 4/01/2011	2,216,000	\$ 0.01	281,000		,	281,000	
yees	16/4/2001	4/16/2001 - 4/15/2011	575,000	\$ 0.01	35,000			35,000	
yees	28/4/2001	4/28/2001 - 4/27/2011	60,000	\$0.01	42,000			42,000	
yees	14/5/2001	5/14/2001 - 5/13/2011	1,597,000	\$0.01	25,000			25,000) \$
yees	15/5/2001	5/15/2001 - 5/14/2011	95,000	\$0.01	35,000			35,000) \$
yees	1/6/2001	6/01/2001 - 5/31/2011	80,000	\$0.01	40,000			40,000) \$
yees	1/7/2001	7/1/2001 - 6/30/2011	745,000	\$0.01	49,000			49,000) \$
yees	15/7/2001	7/15/2001 - 7/14/2011	1,045,000	\$0.01	314,000			314,000) \$
yees	16/7/2001	7/16/2001 - 7/15/2011	2,220,000	\$0.01	88,000			88,000) \$
yees	27/7/2001	7/27/2001 - 7/26/2011	50,000	\$0.01	50,000			50,000	
yees	30/7/2001	7/30/2001 - 7/29/2011	140,000	\$0.01	100,000			100,000) \$
yees	1/8/2001	8/01/2001 - 7/31/2011	195,000	\$0.01	54,000			54,000	
yees	7/8/2001	8/07/2001 - 8/06/2011	20,000		20,000			20,000	
yees	15/8/2001	8/15/2001 - 8/14/2011	100,000		100,000			100,000	
yees	20/8/2001	8/20/2001 - 8/19/2011	20,000		20,000			20,000	
yees	24/9/2001	9/24/2001 - 9/23/2011	98,708,500		18,536,700	50,000	1,167,000	17,319,700	
yees	28/9/2001	9/28/2001 - 9/27/2011	50,000		50,000			50,000	
yees	24/1/2002	1/24/2002 - 1/23/2012	47,653,000		11,836,500	10,000	840,000	10,986,500	-
yees	24/1/2002	1/24/2002 - 1/23/2012	7,684,500		1,156,800	22,500	25,000	1,109,300	
yees	10/4/2002	4/10/2002 - 4/09/2012	1,315,000		10,000	240.000	505 000	10,000	
yees	10/4/2002	4/10/2002 - 4/09/2012	47,349,000		11,915,900	340,000	505,000	11,070,900	
yees	11/4/2002	4/11/2002 - 4/10/2012	4,100,000		2,100,000		2 806 000	2,100,000	-
yees	28/6/2002	6/28/2002 - 6/27/2012	39,740,000		10,544,000		2,806,000 10,000	7,738,000	
yees ishi,	28/6/2002	6/28/2002 - 6/27/2012	18,944,000	φ 0.03	7,734,000		10,000	7,724,000	φ υ. 03
hi	11/7/2002	7/11/2002 - 7/10/2012	500,000	\$0.05	500,000			500,000) \$
yees	11/7/2002	7/11/2002 - 7/10/2012	2,780,000		80,000			80,000	
,,	11112002		_,, 50,000	÷ 0.00	30,000			00,000	· •

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)									
ers	26/9/2002	9/26/2002 - 9/25/2012	50,000	\$0.05	50,000			50,000	\$
yees	26/9/2002	9/26/2005 - 9/25/2012	5,770,000	\$0.02	1,555,000		50,000	1,505,000	\$0.07
yees	26/9/2002	9/26/2005 - 9/25/2012	65,948,300	\$0.05	20,006,310	34,300	2,738,100	17,233,910	0.08
yees	9/1/2003	1/09/2003 - 1/08/2013	53,831,000	\$0.05	21,090,400	28,000	3,726,000	17,336,400	\$ 0.08

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						Opti	ions		
						Lap	sed		Shar
						Di	ue	ir	nmedi
						to	D		
						Repur	chase		befo
						0	f		Date
									on
			No. of	Exercise	e Options		naryOptions Opti		whic
ible		Period during which	Options	Price	Outstanding	Lapsed Sha	resExercisedanc	ell@dutstanding	Optic
	Date			Per	as of		ing During Dur		wer
S	Granted	Rights Exercisable	Granted	Share	12/31/07	Period Peri	od* Period Per	iod 06/30/08	Exerci
				(USD)					(USI
8	10/1/2003	1/10/2003 - 1/09/2013	720,000	\$ 0.05	720,000		720,000		\$0.0
s	22/1/2003	1/22/2003 - 1/21/2013	1,060,000		1,060,000		,	1,060,000	
S	1/4/2003	4/01/2003 - 3/31/2013	18,804,900		7,995,638	127,700	463,720	7,404,218	
8	15/4/2003	4/15/2003 - 4/14/2013	550,000		550,000		,	550,000	
ent	24/4/2003	4/24/2003 - 4/23/2013	1,500,000	\$ 0.05	1,450,000			1,450,000	\$
5	24/4/2003	4/24/2003 - 4/23/2013	58,838,000		23,369,400	18,000	2,838,000	20,513,400	
8	15/7/2003	7/15/2003 - 7/14/2013	59,699,900		20,347,020	172,000	1,282,000	18,893,020	
ŝ	10/10/2003	10/10/2003 - 10/09/2013	49,535,400		24,161,900	4,543,000	1,202,000	19,618,900	
S	5/1/2004	1/05/2004 - 1/04/2014	130,901,110		68,598,317	2,576,875	112,602	65,908,840	
,	15/1/2004	1/15/2004 - 1/14/2014	1,000,000	\$0.10	1,000,000			1,000,000	\$
	15/1/2004	1/15/2004 - 3/01/2005	4,100,000	\$0.10	100,000			100,000	\$
ent	15/1/2004	1/15/2004 - 1/14/2014	10,700,000	\$0.10	1,955,000			1,955,000	\$
	15/1/2004	1/15/2004 - 1/14/2014	4,600,000		2,500,000			2,500,000	
8	15/1/2004	1/15/2004 - 1/14/2014	20,885,000	\$0.10	8,004,000	400,000		7,604,000	\$
ent	16/2/2004	2/16/2004 - 2/15/2014	900,000	\$0.25	700,000			700,000	\$
	16/2/2004	2/16/2004 - 2/15/2014	12,300,000		6,130,000			6,130,000	
s			14,948,600			271,000		4,682,500	
S	16/2/2004	2/16/2004 - 2/15/2014	76,454,880		44,616,360	1,938,630		42,677,730	
S S	16/2/2004	2/16/2004 - 2/15/2014	14,948,600	\$0.10	4,953,500	271,000 1,938,630		4,682,50	00

2001 Preference Share Plans

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									inglos
									e Prie
								of	o
						Options		01	01
						Lapsed			eSha
I						Due	1m	medi	iatelyd
I						to		1 0	1 6
						Repurchase			rebefo
						of			es Dat
			Neef	P ia	Ontions	On the second Partice	ontions	on	-
/E1: -: h1-		Denie i ierzie a miliek		Exercise	I	OptionsOrd aptoption	•		chwhi
me/Eligible	Deta	Period during which	Options	Price	Outstanding	Lapsed SlEarescaiseel		•	-
1	Date	D'alte Essentiali	Constant.	Per	as of	During Duribugingin	C		e we
ployees	Granted	Rights Exercisable	Granted	Share	12/31/07	Period PeriBerRatio	d 6/30/08E		
				(USD)				(051	D)US
ployees	24/9/2001	9/24/2001 - 9/23/2011	249,098,700	\$0.11	22,274,200	724,000	21,550,200	0 \$	\$0.
ployees	28/9/2001	9/28/2001 - 9/27/2011	50,000	\$0.11	50,000	·	50,000		\$0.
ployees	3/11/2001	11/03/2001 - 11/02/2011	780,000	\$0.35	515,000		515,000		\$0.
ployees	24/1/2002	1/24/2002 - 1/23/2012	58,357,500	\$0.11	5,771,500	185,000	5,586,50		\$0.
ployees	10/4/2002	4/10/2002 - 4/09/2012	51,384,000	\$0.11	3,351,900	135,000	3,216,900		\$0.
ployees	28/6/2002	6/28/2002 - 6/27/2012	63,332,000		9,282,500	1,420,000	7,862,50		\$0.
vice						, .			
viders	11/7/2002	7/11/2002 - 7/10/2012	462,000	\$0.11	202,000		202,000	0 \$	\$0.
ployees	11/7/2002	7/11/2002 - 7/10/2012	4,530,000	\$0.11	805,000		805,000	0 \$	\$0.
vice									
viders	26/9/2002	9/26/2002 - 9/25/2012	50,000	\$0.11	50,000		50,000	0 \$	\$0.
ployees	26/9/2002	9/26/2002 - 9/25/2012	73,804,800	\$0.11	12,383,900	364,400	12,019,50	0 \$	\$0.
ployees	9/1/2003	1/09/2003 - 1/08/2013	12,686,000	\$0.11	1,237,000		1,237,00	0 \$	\$0.
1									

2004 Stock Option Plan

								eigh Me
								vera
								Closin
								Price
						- ·		of
						Options		Shares
						Lapsed		ne dian
						Due		before
						to		Datesł
						Repurchase		on 1
						of		which
71:~:1-1-		Devied during which		Exercise		dditionaDptionsOrdDptQptson		Option
Eligible		Period during which	Options	Price	-	Options Lapsed SlEarescaiseelle Granted	outstanding	were
	Date			Per	as of	During During Durlinglinging		
/ees	Granted	Rights Exercisable	Granted	Share	12/31/07	Period Period Period Period	06/30/08Ex	xerci@
				(USD)			((USD)
ement	18/3/2004	3/18/2004 - 3/17/2014	150,000	\$ 0.35	150,00	0	150,000	\$ 5
	18/3/2004	3/18/2004 - 3/17/2014	20,000	\$0.35	20,00	0	20,000	\$ \$
vees	18/3/2004	3/18/2004 - 3/17/2014	49,949,700	\$0.35	29,733,60	0 1,769,900	27,963,700	\$ 5
1	7/4/2004	4/07/2004 - 4/06/2014	100,000	\$0.31	100,00	0	100,000	\$ 5
/ees	25/4/2004	4/25/2004 - 4/24/2014	22,591,800	\$0.28	14,511,90	0 1,491,700	13,020,200	\$ \$
	27/7/2004	7/27/2004 - 7/26/2014	200,000		100,00		100,000	
/ees	27/7/2004	7/27/2004 - 7/26/2014	35,983,000		19,257,00		18,483,200	
ishi,			, ,		, ,		, ,	
hi	10/11/2004	11/10/2004 - 11/09/2009	500,000	\$0.22	500,00	0	500,000	\$ 5
/ees	10/11/2004	11/10/2004 - 11/09/2014	52,036,140	\$0.22	27,125,12	5 2,223,145	24,901,980	\$ \$
Hsu	10/11/2004	11/10/2004 - 11/09/2009	500,000	\$0.22	500,00	0	500,000	\$ 5
Shaw	10/11/2004	11/10/2004 - 11/09/2009	500,000	\$0.22	500,00	0	500,000	\$ 5
Tan	10/11/2004	11/10/2004 - 11/09/2009	500,000	\$0.22	500,00	0	500,000	\$ \$
Ƴang	10/11/2004	11/10/2004 - 11/09/2009	500,000	\$0.22	500,00	0	500,000	\$
	10/11/2004	11/10/2004 - 11/0//2007	500,000	Ψ 0.22	500,00	0	500,000	ψι
ement	11/5/2005	5/11/2005 - 5/10/2015	1,100,000		700,00		700,000	
	11/5/2005	5/11/2005 - 5/10/2015	100,000	\$0.20	100,00	0	100,000	\$ \$
vees	11/5/2005	5/11/2005 - 5/10/2015	94,381,300	\$0.20	62,441,23	6 4,239,295	58,201,941	\$ \$
1	11/5/2005	5/11/2005 - 5/10/2015	15,000,000	\$0.20	15,000,00	0	15,000,000	\$ 5
/ees	11/8/2005	8/11/2005 - 8/10/2015	32,279,500	\$0.22	17,821,70	0 1,594,200	16,227,500	\$ \$
ement	11/11/2005	11/11/2005 - 11/10/2015	11,640,000	\$0.15	8,240,00	0	8,240,000	\$ 5
	11/11/2005	11/11/2005 - 11/10/2015	3,580,000		3,580,00		3,580,000	
/ees	11/11/2005	11/11/2005 - 11/10/2015	149,642,000		114,736,20		108,081,800	

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						Options	S
						Lapsed	imm
						Due	b
						to	Ι
						Repurchase	
						of	W O I O
	Period during which	No. of Options	Exercise Price	Options Outstanding	Additional Options	Options Ord inptopts or Lapsed Sl Earceaised I	· · ·
					Granted		
Date			Per	as of	During	During Duffinglinging	
Granted	Rights Exercisable	Granted	Share (USD)	12/31/07	Period	Period Period	d 06/30/08 Ex (I
20/2/2006	2/20/2006 - 2/19/2016	62,756,470	\$0.15	45,087,976		4,132,277	40,955,699
12/5/2006	5/12/2006 - 5/11/2016	22,216,090		17,319,000		1,160,400	16,158,600
29/9/2006	9/29/2006 - 9/28/2011	500,000	\$0.13	500,000			500,000
29/9/2006	9/29/2006 - 9/28/2011	400,000	\$0.13	400,000		400,000	
29/9/2006	9/29/2006 - 9/28/2016	40,394,000	\$0.13	32,359,500		2,676,400	29,683,100
			* • • •				
29/9/2006	9/29/2006 - 9/28/2016	500,000		500,000			500,000
29/9/2006	9/29/2006 - 9/28/2011	500,000		500,000			500,000
29/9/2006	9/29/2006 - 9/28/2011	500,000		500,000			500,000
29/9/2006	9/29/2006 - 9/28/2011	500,000	\$0.13	500,000			500,000
29/9/2006	9/29/2006 - 9/28/2011	500,000	\$0.13	500,000			500,000
29/9/2006	9/29/2006 - 9/28/2011	500,000	\$0.13	500,000			500,000
10/11/2006	11/10/2006 - 11/09/2016	2,450,000	\$0.13	2,150,000			2,150,000
10/11/2006	11/10/2006 - 11/09/2016	33,271,000	\$0.11	24,821,000		2,486,000	22,335,000
16/5/2007	5/16/2007 - 5/15/2017	123,528,000	\$0.15	112,975,000		9,428,250	103,546,750
16/5/2007	5/16/2007 - 5/15/2017	1,300,000		1,300,000			1,300,000
16/5/2007	5/16/2007 - 5/15/2017	5,421,000		5,421,000		420,000	5,001,000
28/12/2007	12/28/2007 - 12/27/2017	88,339,000		88,339,000		15,356,000	72,983,000
28/12/2007	12/28/2007 - 12/27/2017	5,300,000		5,300,000			5,300,000
12/2/2008	2/12/2008 - 2/11/2018	127,441,000			127,441,000	8,577,700	118,863,300
12/2/2008	2/12/2008 - 2/11/2018	600,000	\$0.08		600,000		600,000
12/2/2008	2/12/2008 - 2/11/2018	1,800,000	\$0.08		1,800,000		1,800,000

2004 Equity Incentive Plan

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	Period during which	No. of Options	Exercise Price	e Options Outstanding	Additional Options	·	naryOptionsOpti resExercisedance	•
Deta			Der	of	Granted	Derine Du		· · · · · · · · · · · · · · · · · · ·
Date Granted	Rights Exercisable	Granted	Per Share (USD)	as of 12/31/07	During Period	0	ing During Dur od* Period Peri	0
1/7/2004	7/01/2005 - 6/30/2015	96,856,590	\$ 0.00	14,775,610		1,462,000	14,999	13,298,611
27/7/2004	7/27/2005 - 7/26/2015	1,130,000	\$ 0.00	257,500				257,500
27/7/2004	7/27/2005 - 7/26/2015	19,447,520	\$ 0.00	3,086,880		85,000	50,000	2,951,880
11/5/2005	5/11/2006 - 5/10/2016	4,630,000	\$ 0.00	740,000		57,500	210,000	472,500
11/5/2005	5/11/2006 - 5/10/2016	2,000,000	\$ 0.00	500,000				500,000
11/8/2005	8/11/2005 - 8/10/2015	916,830		409,568			48,848	360,720
11/8/2005	8/11/2005 - 8/10/2015	156,888	0.00	18,788				18,788
11/8/2005	8/11/2005 - 8/10/2015	69,430,022	\$ 0.00	25,158,274		1,607,293	436,239	23,114,742
11/11/2005	11/11/2005 - 11/10/2015	2,910,000		1,545,000			515,000	1,030,000
11/11/2005	11/11/2005 - 11/10/2015	2,100,000		1,075,000			25,000	1,050,000
11/11/2005	11/11/2005 - 11/10/2015	40,275,000		24,046,250		720,000	7,326,250	16,000,000
20/2/2006	2/20/2006 - 2/19/2016	3,110,000		1,647,500		595,000	442,500	610,000
12/5/2006	5/12/2006 - 5/11/2016	2,700,000		2,450,000		50,000	650,000	1,750,000
29/9/2006	9/29/2006 - 9/28/2016	720,000	\$ 0.00	390,000		75,000		315,000
29/9/2006	9/29/2006 - 9/28/2016	500,000	\$0.00	500,000				500,000
10/11/2006	11/10/2006 - 11/09/2016	1,688,864	\$0.00	1,616,648			350,000	1,266,648
10/11/2006	11/10/2006 - 11/09/2016	7,340,000	\$0.00	4,425,000		521,250	420,000	3,483,750
16/5/2007	5/16/2007 - 5/15/2017	33,649,720		29,930,790		1,657,750	7,162,000	21,111,040
16/5/2007	5/16/2007 - 5/15/2017	1,000,000		1,000,000			250,000	750,000
28/12/2007	12/28/2007 - 12/27/2017	4,910,000		4,910,000		300,000		4,610,000
28/12/2007	12/28/2007 - 12/27/2017	960,000		960,000				960,000
12/2/2008	2/12/2008 - 2/11/2018	38,817,100	\$ 0.00		38,817,100	2,308,550		36,508,550
4								

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12/2/2008	2/12/2008 - 2/11/2018	270,000 \$0.00	270,000	270,000
12/2/2008	2/12/2008 - 2/11/2018	740,000 \$0.00	740,000	740,000

5. Repurchase, Sale Or Redemption Of Securities

The Company has not repurchased, sold or redeemed any of its securities during the six months ended June 30, 2008.

6. Material Litigation And Arbitration

Overview of TSMC Litigation:

Beginning in December 2003 through August 2004, the Company became subject to several lawsuits brought by Taiwan Semiconductor Manufacturing Company, Limited (TSMC) relating to alleged infringement of certain patents and misappropriation of alleged trade secrets relating to methods for conducting semiconductor fab operations and manufacturing integrated circuits.

On January 31, 2005, the Company entered into a settlement agreement, without admission of liability, which provided for the dismissal of all pending legal actions without prejudice between the two companies (the Settlement Agreement). The terms of the Settlement Agreement also included:

- 1) The Company and TSMC agreed to cross-license each other s patent portfolio for all semiconductor device products, effective from January 2005 through December 2010.
- 2) TSMC covenanted not to sue the Company for trade secret misappropriation as alleged in TSMC s legal actions as it related to .15um and larger processes subject to certain conditions (TSMC Covenant). The TSMC Covenant did not cover .13um and smaller technologies after 6 months following execution of the Settlement Agreement (July 31, 2005). Excluding the .13um and smaller technologies, the TSMC Covenant remains in effect indefinitely, terminable upon a breach by the Company.
- 3) The Company is required to deposit certain Company materials relating to .13im and smaller technologies into an escrow account until December 31, 2006 or under certain circumstances for a longer period of time.
- 4) The Company agreed to pay TSMC an aggregate of \$175 million in installments of \$30 million for each of the first five years and \$25 million in the sixth year.

Accounting under the Settlement Agreement:

In accounting for the Settlement Agreement, the Company determined that there were several components of the Settlement Agreement settlement of litigation, covenant not to sue, patents licensed by us to TSMC and the use of TSMC s patent license portfolio both prior and subsequent to the settlement date.

The Company does not believe that the settlement of litigation, covenant not to sue or patents licensed by us to TSMC qualify as accounting elements. In regard to the settlement of litigation, the Company cites the following:

The settlement agreement reached between TSMC and SMIC clearly stated that there was no admission of liability by either party;

The settlement agreement required all parties to bear their own legal costs;

There were no other damages associated with the Settlement Agreement;

There was a provision in the Settlement Agreement for a grace period to resolve any misappropriation issues had they existed;

Although a complaint had been filed by TSMC on trade secret infringement, TSMC has never identified which trade secrets it claimed were being infringed upon by the Company;

The Settlement Agreement was concluded when the litigation process was still at a relatively early stage and the outcome of the litigation was therefore highly uncertain.

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The TSMC covenant not to sue for alleged trade secrets misappropriation does not qualify as a separable asset in accordance with either SFAS 141 or SFAS 142 as TSMC had never specified the exact trade secrets that it claimed were misappropriated, the Company s belief that TSMC s trade secrets may be obtained within the marketplace by other legal means and the Company never obtained the legal right to use TSMC s trade secrets.

In addition, the Company did not attribute any value to the patents licensed to TSMC under the Settlement Agreement due to the limited number of patents held by the Company at the time of the Settlement Agreement.

As a result, the Company determined that only the use of TSMC s patent license portfolio prior and subsequent to the settlement date were considered elements of an arrangement for accounting purposes. In attributing value to these two elements, the Company first discounted the payment terms of the \$175 million settlement amount using an annual 3.4464% interest rate to arrive at a net present value of \$158 million. This amount was then allocated to the pre- and post-settlement periods based on relative fair value, as further described below.

Based on this approach, \$16.7 million was allocated to the pre-settlement period, reflecting the amount that the Company would have paid for use of the patent license portfolio prior to the date of the Settlement Agreement. The remaining \$141.3 million, representing the relative fair value of the licensed patent license portfolio, was recorded on the Company s consolidated balance sheets as a deferred cost and is being amortized over a six-year period, which represents the life of the licensed patent license portfolio. The amortization of the deferred cost is included as a component of cost of sales in the consolidated statements of operations.

Valuation of Deferred Cost

The fair value of the patent license portfolio was calculated by applying the estimated royalty rate to the specific revenue generated and expected to be generated from the specific products associated with the patent license portfolio. The selected royalty rate was based on the review of median and mean royalty rates for the following categories of licensing arrangements:

- a) Existing third-party license agreements with SMIC;
- b) The analysis of comparable industry royalty rates related to semiconductor chip/integrated circuit (IC) related technology; and
- c) The analysis of comparable industry royalty rates related to semiconductor fabrication.

On an annualized basis, the amounts allocated to past periods was lower than that allocated to future periods as the Company assumed increases in revenues relating to the specific products associated with the patent license portfolio. As the total estimated fair value of the patent license portfolio exceeded the present value of the settlement amount, the Company allocated the present value of the settlement amount based on the relative fair value of the amounts calculated prior and subsequent to the settlement date.

Recent TSMC Legal Developments:

On August 25, 2006, TSMC filed a lawsuit against the Company and certain subsidiaries (SMIC (Shanghai), SMIC (Beijing) and SMIC (Americas)) in the Superior Court of the State of California, County of Alameda for alleged breach of the Settlement Agreement, alleged breach of promissory notes and alleged trade secret misappropriation by the Company. TSMC seeks, among other things, damages, injunctive relief, attorneys fees, and the acceleration of the remaining payments outstanding under the Settlement Agreement.

In the present litigation, TSMC alleges that the Company has incorporated TSMC trade secrets in the manufacture of the Company s 0.13 micron or smaller process products. TSMC further alleges that as a result of this claimed breach, TSMC s patent license is terminated and the covenant not to sue is no longer in effect with respect to the Company s larger process products.

The Company has vigorously denied all allegations of misappropriation. The Court has made no finding that TSMC s claims are valid, nor has it set a trial date.

On September 13, 2006, the Company announced that in addition to filing a response strongly denying the allegations of TSMC in the United States lawsuit, it filed on September 12, 2006, a cross-complaint against TSMC seeking, among other things, damages for TSMC s breach of contract and breach of implied covenant of good faith and fair dealing.

On November 16, 2006, the High Court in Beijing, the People s Republic of China, accepted the filing of a complaint by the Company and its wholly-owned subsidiaries, SMIC (Shanghai) and SMIC (Beijing), regarding the unfair competition arising from the breach of bona fide (i.e. integrity, good faith) principle and commercial defamation by TSMC (PRC Complaint). In the PRC Complaint, the Company is seeking, among other things, an injunction to stop TSMC s infringing acts, public apology from TSMC to the Company and compensation from TSMC to the Company, including profits gained by TSMC from their infringing acts.

TSMC filed with the California court in January 2007 a motion seeking to enjoin the PRC action. In February 2007, TSMC filed with the Beijing High Court a jurisdictional objection, challenging the competency of the Beijing High Court s jurisdiction over the PRC action.

In March 2007, the California Court denied TSMC s motion to enjoin the PRC action. TSMC appealed this ruling to California Court of Appeal. On March 26, 2008, the Court of Appeal, in a written opinion, denied TSMC s appeal. In July 2007, the Beijing High Court denied TSMC s jurisdictional objection and issued a court order holding that the Beijing High Court shall have proper jurisdiction to try the PRC action. TSMC appealed this order to the Supreme Court of the People s Republic of China. On January 7, 2008, the Supreme Court heard TSMC s appeal. On June 13, 2008, the Supreme Court denied TSMC s appeal and affirmed the jurisdiction of the Beijing High Court. On August 14, 2007, the Company filed an amended cross-complaint against TSMC seeking, among other things, damages for TSMC s breach of contract and breach of patent license agreement. TSMC thereafter denied the

allegations of the Company s amended cross-complaint and subsequently filed additional claims that the Company breached the Settlement Agreement by filing an action in the Beijing High Court. The Company has denied these additional claims by TSMC.

On August 15-17, 2007, the California Court held a preliminary injunction hearing on TSMC s motion to enjoin use of certain process recipes in certain of the Company s 0.13 micron logic process flows. On September 7, 2007, the Court denied TSMC s preliminary injunction motion, thereby leaving unaffected the Company s development and sales. However, the court required the Company to provide 10 days advance notice to TSMC if the Company plans to disclose logic technology to non-SMIC entities under certain circumstances, to allow TSMC to object to the planned disclosure.

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On March 11, 2008, TSMC filed an application for a right to attach order in the California Court. By its application, TSMC sought an order securing an amount equal to the remaining balance on the promissory notes issued by the Company in connection with the Settlement Agreement. The Company opposed the application. A hearing was held on April 3, 2008. On June 24, 2008, the Court denied TSMC sapplication.

In May 2008, TSMC filed a motion in the California Court for summary adjudication against the Company on several of the Company s cross claims. The Company opposed the motion and on July 25, 2008, the Court granted in part and denied in part TSMC s motion.

On June 23, 2008, the Company filed with California court a cross-complaint against TSMC seeking, among other things, damages for TSMC s unlawful misappropriation of trade secrets from SMIC to improve its competitive position against SMIC.

On July 10, 2008, the California Court held and granted part of a preliminary injunction hearing on TSMC s motion to enjoin disclosure of information on certain process recipes in the Company s 0.30 micron logic process flows to 3rd parties.

Under the provisions of SFAS 144, the Company is required to make a determination as to whether or not this pending litigation represents an event that requires a further analysis of whether the patent license portfolio has been impaired. We believe that the lawsuit is at a preliminary stage and we are still evaluating whether or not the litigation represents such an event. The Company expects further information to become available to us which will aid us in making a determination. The outcome of any impairment analysis performed under SFAS 144 might result in a material impact to our financial position and results of operations. Because the case is in its preliminary stages, the Company is unable to evaluate the likelihood of an unfavorable outcome or to estimate the amount or range of potential loss.

7. Changes In The Members Of The Board Of Directors

At the 2008 AGM, Dr. Richard R. Chang and Mr. Henry Shaw were re-elected as Class I executive director and Class I non-executive director of the Company respectively and Mr. Wang Zheng Gang was re-elected as Class III non-executive director of the Company. At the 2008 AGM, Dr. Albert Y. C. Yu retired as a Class I non-executive director of the Company and did not offer himself for re-election.

On August 11, 2008, Mr. Henry Shaw resigned as a member of the Audit Committee of the Company and on the same day, Mr. Jiang Shang Zhou was appointed as a member of the Audit Committee in place of Mr. Shaw.

8. Waiver From Compliance With The Listing Rules

The Stock Exchange has granted a conditional waiver (the Waiver) to the Company from the strict compliance with rule 3.24 of the Listing Rules. Under rule 3.24 of the Listing Rules, the Company must employ an individual on a full-time basis who, amongst other things, must be a qualified accountant and a fellow or associate member of the Hong Kong Institute of Certified Public Accountants (the HKICPA) (previously known as the Hong Kong Society of Accountants) or a similar body of accountants recognized by HKICPA for the purpose of granting exemptions from the examination requirement for membership of HKICPA.

The Waiver is subject to the following conditions:

- Ms. Morning Wu (Ms. Wu), the Acting Chief Financial Officer of the Company, being a member of the senior management of the Company, is able to meet all the requirements set out in rule 3.24 of the Listing Rules, save for being a fellow or associate member of the HKICPA or a similar body of accountants recognized by the HKICPA for the purpose of granting exemptions from the examination requirement for membership of HKICPA; and
- 2. the Company has in place arrangement(s) providing Ms. Wu with access to the assistance of Ms. Mei Fung Hoo, who shall continue to be a member of the HKICPA and Institute of Chartered Accountants in Australia, to provide assistance to Ms. Wu in the discharge of her duties as the Qualified Accountant of the Company during the period of the Waiver.

The Waiver was extended on April 15, 2008 by the SEHK for a further period of 9 months commencing from April 15, 2008 (the Extended Waiver). The Extended Waiver will cease on January 14, 2009 or when the Company fails to fulfill any of the above conditions to the Waiver, whichever is earlier.

Save as disclosed above and in the prospectus of the Company dated March 8, 2004, the Company has not received any waivers from compliance with the Listing Rules

9. Review By Audit Committee

The Audit Committee has reviewed with the management of the Company, the accounting principles and practices accepted by the Group and the interim financial statements of the Company for the six months ended June 30, 2008.

By order of the Board of Directors Semiconductor Manufacturing International Corporation Richard R. Chang Chief Executive Officer

Shanghai, PRC September 19, 2008

Condensed Consolidated Statement of Operations

For the six months ended June 30, 2008 and 2007 (in US\$ thousands, except per share data) (unaudited)

	NOTES				ended June 30, 2007		
Sales Cost of sales	14	\$	705,288 717,016	\$	763,114 687,683		
Gross profit (loss)			(11,728)		75,431		
Operating expenses (income): Research and development General and administrative Selling and marketing Amortization of acquired intangible assets Impairment loss of long-lived assets Income from sales of manufacturing equipment and other fixed assets			71,917 31,934 9,240 13,683 105,774 (1,646)		44,927 31,834 8,127 12,442 (28,495)		
Total operating expenses			230,902		68,835		
Income (Loss) from operations	15		(242,630)		6,596		
Other income (expense): Interest income Interest expense Foreign currency exchange gain (loss) Others, net			7,817 (32,547) 12,796 3,145		5,558 (11,660) (1,086) 1,086		
Total other expense, net			(8,789)		(6,102)		
Income (Loss) before income tax			(251,419)		494		
Income taxes benefit (expense) Minority interest Loss from equity investment	13		(21,188) 2,449 (326)		7,585 840 (2,213)		
Net income (loss) attributable to holders of ordinary shares			(270,484)		6,706		
Income (Loss) per ordinary share, basic		\$	(0.01)	\$	0.00		
Income (Loss) per ordinary share, diluted		\$	(0.01)	\$	0.00		
Shares used in calculating basic income (loss) per ordinary share		18	3,583,169,690	18	,465,759,673		

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Shares used in calculating diluted income (loss) per ordinary18,583,169,69018,718,977,415Share18,583,169,69018,718,977,415The accompanying notes are an integral part of these consolidated financial statements.18,718,977,415

Condensed Consolidated Balance Sheet

As of June 30, 2008 and December 31, 2007 (in US\$ thousands) (unaudited)

NOTE	ES	June 30, 2008	De	ecember 31, 2007
ASSETS				
Current assets:				
Cash and cash equivalents		\$ 480,265	\$	469,284
Restricted Cash	6	91,130		
Short-term investments		32,326		7,638
Accounts receivable, net of allowances of \$4,491,881 and of				
\$4,492,090 on June 30, 2008 and December 31, 2007, respectively	7	262,418		298,388
Inventories	8	252,394		248,310
Prepaid expense and other current assets		43,758		31,237
Receivable for sale of manufacturing equipments and other fixed				
assets		19,504		17,321
Assets held for sale		1,505		3,124
Total current assets		1,183,300		1,075,302
Land use rights, net		56,973		57,552
Plant and equipment, net	9	3,073,940		3,202,958
Acquired intangible assets, net		219,543		232,195
Deferred cost, net		58,864		70,637
Equity investment		9,570		9,896
Other long-term prepayments		2,431		2,988
Deferred tax assets	13	44,483		56,915
TOTAL ASSETS		\$ 4,649,104	\$	4,708,444
LIABILITIES AND STOCKHOLDERS EQUITY				
Current liabilities:				
Accounts payable	10	\$ 345,801	\$	301,993
Short-term borrowings	11	242,908		107,000
Current portion of long-term debts	11	341,630		340,693
Accrued expenses and other current liabilities		130,233		150,110
Current portion of promissory notes	12	29,242		29,242
Income tax payable		482		1,153
Total current liabilities		1,090,296		930,190
Long-term liabilities:				
Promissory notes	12	37,441		51,057
Long-term debts	11	695,292		616,295
Long-term payables relating to license agreements		43,489		62,833
Deferred tax liabilities		621		605

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Total long-term liabilities	776,843	730,790
Total liabilities	1,867,139	1,660,980
Minority interest	32,496	34,944
Stockholders equity: Ordinary shares, \$0.0004 par value, 50,000,000,000 authorized, 18,592,920,335 and 18,558,919,712 shares issued and outstanding		
on June 30, 2008 and December 31, 2007, respectively	7,437	7,424
Additional paid-in capital	3,320,932	3,313,376
Accumulated other comprehensive income (loss)	(137)	(2)
Accumulated deficit	(578,763)	(308,279)
Total stockholders equity	2,749,469	3,012,519
TOTAL LIABILITIES, MINORITY INTEREST, AND		
STOCKHOLDERS EQUITY	\$ 4,649,104	\$ 4,708,444
Net Current Assets	\$ 93,004	\$ 145,112
Total assets less current liabilities The accompanying notes are an integral part of these consolidated financial stateme	\$ 3,558,808 nts.	\$ 3,778,254

Condensed Consolidated Statement of Stockholders Equity And Comprehensive Income (Loss)

For the six months ended June 30, 2008 and 2007 (in US\$ thousands, except share data) (unaudited)

	Ordinary sha	ares	Additional	ot	nulatec her ehensiv	Total stockholders (Total Comprehensive	
	Share	Amount	capital	_	ome	deficit	equity	Income (loss)
Balance at January 1, 2008 Exercise of employee stock	18,558,919,712	\$ 7,424	\$ 3,313,376	\$	(2)	\$ (308,279)	\$ 3,012,519	\$
options Share based	34,000,623	\$ 13	666				679	
compensation Net loss Foreign currency			6,890			\$ (270,484)	6,890 (270,484)	(270,484)
translation adjustments					(135)		(135)	(135)
Balance at June 30, 2008	18,592,920,335	\$ 7,437	\$ 3,320,932	\$	(137)	\$ (578,763)	\$ 2,749,469	\$ (270,619)
Balance at January 1, 2007	18,432,756,463	\$ 7,373	\$ 3,288,765	\$	92	\$ (288,810)	\$ 3,007,420	
Exercise of employee stock options	60,427,587	24	2,508				2,532	
Share based compensation Net income	00,121,007	21	11,003			6,706	11,003 6,706	\$ 6,706
Foreign currency translation adjustments					(27)		(27)	(27)
Balance at June 30, 2007 The accompanying	18,493,184,050 notes are an integr	\$ 7,397 al part of t	\$ 3,302,276 hese consolida	\$ ited fin	65 nancial	\$ (282,104) l statements.	\$ 3,027,634	\$ 6,679

Condensed Consolidated Statement of Cash Flows

For the six months ended June 30, 2008 and 2007 (in US\$ thousands) (unaudited)

	Six months en 2008	nded June 30, 2007
Operating activities:		
Net Income (Loss)	\$ (270,484)	\$ 6,706
Adjustments to reconcile net income (loss) to net cash provided by operating activities:		
Minority interest	(2,449)	(840)
Deferred tax	12,449	(7,777)
Gain on disposal of plant and equipment	(1,646)	(28,495)
Depreciation and amortization	379,641	348,558
Non-cash interest expense on promissory notes and long-term payable		
relating to license agreements	3,912	2,403
Amortization of acquired intangible assets	13,683	12,442
Share-based compensation	6,890	11,003
Loss from equity investment	326	2,213
Loss on impairment of long-lived assets	105,774	
Changes in operating assets and liabilities:		
Accounts receivable	35,970	(48,194)
Inventories	(4,084)	37,213
Prepaid expense and other current assets	(13,321)	8,276
Accounts payable	17,130	(10,790)
Accrued expenses and other current liabilities	322	4,209
Income tax payable	(671)	87
Other long-term liabilities		(3,333)
Net cash provided by operating activities	283,442	333,681
Investing activities:		
Purchase of plant and equipment	(318,564)	(317,723)
Proceeds received from assets held for sale	1,333	6,466
Proceeds from disposal of plant & equipment	494	9,751
Purchase of acquired intangible assets	(41,292)	(6,452)
Acquisition of minority interest		(1,000)
Purchase of short-term investments	(136,822)	(63,844)
Sale of short-term investments	112,134	48,715
Change in restricted cash	(91,130)	
Net cash used in investing activities	(473,847)	(324,087)
Financing activities:		
Proceeds from short-term debts	280,488	107,000
Repayment of short-term debts	(144,580)	(70,000)

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Repayment of promissory notes Proceeds from long-term debts		(15,000) 250,715		(15,000)	
Repayment of long-term debts		(170,781)		(25,271)	
Proceeds from exercise of employee stock options		680		2,533	
Net cash provided by (used in) financing activities		201,521		(738)	
Effect of exchange rate changes		(135)		(27)	
Net increase in cash and cash equivalents		10,981		8,829	
Cash and cash equivalents, beginning of period		469,284		363,620	
Cash and cash equivalents, end of period	\$	480,265	\$	372,449	
SUPPLEMENTAL DISCLOSURE OF CASH FLOW INFORMATION: Income taxes paid	\$	9,410	\$	130	
•					
Interest paid	\$	26,717	\$	18,122	
SUPPLEMENTAL DISCLOSURES OF NON-CASH INVESTING OR FINANCING ACTIVITIES					
Inception of accounts payable for plant and equipment	\$	(165,518)	\$	(351,415)	
Inception of long-term payable for acquired intangible assets	\$	(43,489)	\$	(14,458)	
Inception of receivable for sales of manufacturing equipment and other fixed assets The accompanying notes are an integral part of these consolidated financial sta	\$ teme	19,504 nts.	\$	109,908	

Notes to the Condensed Consolidated Financial Statements

For the six months ended June 30, 2008 and 2007 (unaudited; in US\$ thousands)

1. Basis Of Presentation

The accompanying consolidated financial statements include the results of Semiconductor Manufacturing International Corporation and subsidiaries (the Company). All inter-company accounts and transactions have been eliminated in consolidation. The interim consolidated financial statements included herein are unaudited and have been prepared in accordance with accounting principles generally accepted in the United State of America, or GAAP and applicable rules and regulations of the Securities and Exchange Commission, regarding interim financial reporting and Appendix 16, Disclosure of financial information, of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited. They do not include all of the information and footnotes required by generally accepted accounting principles for complete financial statements. Accordingly, these interim consolidated financial statements should be read in conjunction with the audited consolidated financial statements and accompanying notes thereto contained in the Company s Annual Report for the year ended December 31, 2007 dated on April 25, 2008. The December 31, 2007 consolidated balance sheet included herein was derived from the audited financial statements as of that date, but does not include all disclosures including notes required by GAAP. In the opinion of management, these interim consolidated financial statements reflect all adjustments of a normal recurring nature necessary to present fairly the Company s results for the interim periods. The preparation of financial statements in conformity with GAAP requires management to make certain estimates and assumptions. These estimates and assumptions affect the reported amounts of assets and liabilities as of the date of the financial statements, as well as the reported amount of revenue and expenses during the reporting periods. Actual results could differ from those estimates. In addition, the Company s operating results for the six months ended June 30, 2008 may not be indicative of the operating results for the full fiscal year or any other future period.

2. Recently Issued Accounting Standards

On January 1, 2008, the Company adopted Financial Accounting Standards Board (FASB) Statement of Financial Accounting Standards (SFAS) No. 157 Fair Value Measurements (SFAS No. 157) for all financial assets and financial liabilities and for all non-financial assets and non-financial liabilities recognized or disclosed at fair value in the financial statements on a recurring basis (at least annually). SFAS No. 157 defines fair value, establishes a framework for measuring fair value, and enhances fair value measurement disclosure. The adoption of SFAS No. 157 did not have a significant impact on our consolidated financial statements, and the resulting fair values calculated under SFAS No. 157 after adoption were not significantly different than the fair values that would have been calculated under previous guidance. See Note 3: Fair Value for further details on our fair value measurements. In February 2008, the Financial Accounting Standards Board (FASB) issued FASB Staff Position (FSP) 157-1,

Application of FASB Statement No. 157 to FASB Statement No. 13 and Other Accounting Pronouncements That Address Fair Value Measurements for Purposes of Lease Classification or Measurement under Statement 13 (FSP 157-1) and FSP 157-2, Effective Date of FASB Statement No. 157 (FSP 157-2). FSP 157-1 amends SFAS No. 157 to remove certain leasing transactions from its scope. FSP 157-2 delays the effective date of SFAS No. 157 for all non-financial assets and non-financial liabilities, except for items that are recognized or disclosed at fair value in the financial statements on a recurring basis (at least annually), until January 1, 2009. We are currently evaluating the impact that SFAS No. 157 will have on our consolidated financial statements when it is applied to non-financial assets and non-financial liabilities that are not measured at fair value on a recurring basis on January 1, 2009.

2. Recently Issued Accounting Standards (Continued)

In February 2007, the FASB issued SFAS No.159, The Fair Value Option for Financial Assets and Financial Liabilities . The standard requires unrealized gains and losses to be included in earnings for items reported using the fair value option. SFAS No.159 permits companies to choose to measure many financial instruments and certain other items at fair value. SFAS No.159 is effective for financial statements issued for fiscal years beginning after November 15, 2007. The Company did not elect the fair value option described in SFAS No.159 for financial instruments and certain other items.

In December 2007, the FASB issued Statement No. 141 (revised 2007) Business Combinations (SFAS 141(R)). SFAS 141(R) retains the fundamental requirements of the original pronouncement requiring that the purchase method be used for all business combinations. SFAS 141(R) defines the acquirer as the entity that obtains control of one or more businesses in the business combination, establishes the acquisition date as the date that the acquirer achieves control and requires the acquirer to recognize the assets acquired, liabilities assumed and any non-controlling interest at their fair values as of the acquisition date. SFAS 141(R) also requires that acquisition-related costs be recognized separately from the acquisition. SFAS 141(R) is applicable to the Company s business combinations, if any, occurring after January 1, 2009. SFAS 141(R) has no impact on previously consummated business combinations. The adoption of SFAS No. 141 (R) will change the Company s accounting treatment for business combinations on a prospective basis, beginning January 1, 2009.

In December 2007, the FASB issued Statement No. 160 Non-controlling Interests in Consolidated Financial Statements, an amendment of ARB 51 (SFAS 160). SFAS 160 requires non-controlling interests in subsidiaries initially to be measured at fair value and classified as a separate component of equity. SFAS 160 also requires that when a parent company acquires control of a subsidiary, it must include 100% of the fair value of all the acquired company s assets and liabilities in its consolidated financial statements. SFAS 160 is effective for us on January 1, 2009. SFAS 160 is to be applied prospectively to business combinations occurring; certain disclosure and presentation requirements are to be applied retrospectively upon adoption. The Company is currently evaluating whether the adoption of SFAS 160 will have a material impact on the Company s consolidated financial position, results of operations or cash flow.

On March 19, 2008, the FASB issued Statement No. 161, Disclosures about Derivative Instruments and Hedging Activities an Amendment of FASB Statement 133, or Statement 161. Statement 161 enhances required disclosures regarding derivatives and hedging activities, including enhanced disclosures regarding how: (a) an entity uses derivative instruments; (b) derivative instruments and related hedged items are accounted for under FASB Statement No 133, Accounting for Derivative Instruments and Hedging Activities. and (c) derivative instruments and related hedged items affect an entity s financial position, financial performance, and cash flows. Specifically, Statement 161 requires:

Disclosure of the objectives for using derivative instruments in terms of underlying risk and accounting designation;

Disclosure of the fair values of derivative instruments and their gains and losses in a tabular format;

Disclosure of information about credit-risk-related contingent features; and

Cross-reference from the derivative footnote to other footnotes in which derivative-related information is disclosed.

SFAS 161 is effective for periods beginning after November 15, 2008. The Company has not yet determined the impact on its consolidated financial statements of adopting SFAS No. 161.

2. **Recently Issued Accounting Standards** (Continued)

In April, 2008, the FASB issued FASB Staff Position No. FAS 142-3, Determination of the Useful Life of Intangible Assets (FSP FAS 142-3). In determining the useful life of acquired intangible assets, FSP FAS 142-3 removes the requirement to consider whether an intangible asset can be renewed without substantial cost of material modifications to the existing terms and conditions and, instead, requires an entity to consider its own historical experience in renewing similar arrangements. FSP FAS 142-3 also requires expanded disclosure related to the determination of intangible asset useful lives. FSP FAS 142-3 is effective for fiscal years beginning after December 15, 2008. The guidance for determining the useful life of a recognized intangible asset must be applied prospectively to intangible assets acquired after the effective date. Early adoption is prohibited. The Company is currently evaluating the potential impact of FSP FAS 142-3 on its consolidated financial statements.

In May 2008, the FASB issued SFAS No. 162, The Hierarchy of Generally Accepted Accounting Principles. SFAS No. 162 identifies the sources of accounting principles and provides entities with a framework for selecting the principles used in preparation of financial statements that are presented in conformity with GAAP. The current GAAP hierarchy has been criticized because it is directed to the auditor rather than the entity, it is complex, and it ranks FASB Statements of Financial Accounting Concepts, which are subject to the same level of due process as FASB Statements of Financial Accounting Standards, below industry practices that are widely recognized as generally accepted but that are not subject to due process. The adoption of FASB 162 is not expected to have a material impact on the Company s consolidated financial position and results of operations.

Fair Value 3.

SFAS No. 157 defines fair value as the price that would be received from selling an asset or paid to transfer a liability in an orderly transaction between market participants at the measurement date. When determining the fair value measurements for assets and liabilities required or permitted to be recorded at fair value, we consider the principal or most advantageous market in which we would transact and we consider assumptions that market participants would use when pricing the asset or liability, such as inherent risk, transfer restrictions, and risk of nonperformance.

Fair Value Hierarchy

SFAS No. 157 establishes a fair value hierarchy that requires an entity to maximize the use of observable inputs and minimize the use of unobservable inputs when measuring fair value. Observable inputs are obtained from independent sources and can be validated by a third party, whereas unobservable inputs reflect assumptions regarding what a third party would use in pricing an asset or liability. A financial instrument s categorization within the fair value hierarchy is based upon the lowest level of input that is significant to the fair value measurement. SFAS No. 157 establishes three levels of inputs that may be used to measure fair value:

Level 1 - Quoted prices in active markets for identical assets or liabilities.

Level 1 assets and liabilities consist of money market fund deposits that are traded in an active market with sufficient volume and frequency of transactions.

Level 2 - Observable inputs other than Level 1 prices such as quoted prices for similar assets or liabilities; quoted prices in markets with insufficient volume or infrequent transactions (less active markets); or model-derived valuations in which all significant inputs are observable or can be derived principally from or corroborated by observable market data for substantially the full term of the assets or liabilities.

Level 2 assets include derivative financial instruments priced using inputs that are observable in the market or can be derived principally from or corroborated by observable market data.

3. Fair Value (Continued)

Fair Value Hierarchy (Continued)

Level 3 - Unobservable inputs to the valuation methodology that are significant to the measurement of fair value of assets or liabilities.

Assets/Liabilities Measured at Fair Value on a Recurring Basis

Assets and liabilities measured at fair value on a recurring basis, excluding accrued interest components, consisted of the following types of instruments as of June 30, 2008:

	Fair Value Measurements at Reporting D Quoted Prices in Active Significant Markets for Other Significant Identical Observable Unobservable Instruments Inputs Inputs (Level 1) (Level 2) (Level 3)				Date Using Total Balance		
Assets Money market fund deposits Derivative assets Total assets measured at fair value	\$	46,043 46,043	\$	4,282 4,282	\$	\$	46,043 4,282 50,325
Liabilities Derivative liabilities Total liabilities measured at fair value	\$		\$	2,313 2,313	\$	\$	2,313 2,313
		46					

3. Fair Value (Continued)

Fair Value Hierarchy (Continued)

Assets and liabilities measured and recorded at fair value on a recurring basis, excluding accrued interest components, were presented on our consolidated balance sheets as of June 30, 2008 as follows:

(In Thousands)	in Ma Ic Ins	Fair Va Quoted Prices Active rkets for lentical truments .evel 1)	Sig (Obs I	leasuremen mificant Other servable nputs evel 2)	nts at Reporting D Significant Unobservable Inputs (Level 3)		ng 1 Balance	
	(1		(1	ever 2)		1014	Durunee	
Assets								
Cash and cash equivalents		46,043		4.000			46,043	
Prepaid expense and other current assets				4,282			4,282	
Total assets measured at fair value	\$	46,043	\$	4,282	\$	\$	50,325	
Liabilities								
Accrued expenses and other current liabilities				2,313			2,313	
Total liabilities measured at fair value	\$		\$	2,313	\$	\$	2,313	
We price our derivative financial instruments, consisting of forward foreign exchange contracts and interest rate swap								

contracts using quoted market prices for similar instruments or pricing models, such as discounted cash flow techniques, with all significant inputs derived from or corroborated by observable market data. Discounted cash flow techniques use observable market inputs, such as LIBOR-based yield curves, currency spot, forward rates, and credit ratings.

4. Revenue Recognition

The Company manufactures semiconductor wafers for its customers based on the customers designs and specifications pursuant to manufacturing agreements and/or purchase orders. The Company also sells certain semiconductor standard products to customers. The Company recognizes revenue to customers upon shipment and title transfer. The Company also provides certain services, such as mask making, testing and probing. Revenue is recognized when the services are completed or upon shipment of semiconductor products.

Customers have the right of return within one year pursuant to warranty and sales return provisions, which has been minimal. The Company typically performs tests of its products prior to shipment to identify yield rate per wafer. Occasionally, product tests performed after shipment identify yields below the level agreed with the customer. In those circumstances, the customer arrangement may provide for a reduction to the price paid by the customer or for the costs to return products and to ship replacement products to the customer. The Company estimates the amount of sales returns and the cost of replacement products based on the historical trend of returns and warranty replacements relative to sales as well as a consideration of any current information regarding specific known product defects at customers that may exceed historical trends.

The Company was contracted to provide management services to certain government-owned foundries. Service revenue is recognized when persuasive evidence of an arrangement exists, service has been performed, the fee is fixed or determinable, and collection is reasonably assured.

5. Share-based Compensation

The Company grants stock options to its employees and certain non-employees. The Company adopted the provisions of Statement of Financial Accounting Standards No. 123(R), (SFAS 123(R)) Share-Based Payment, which establishes accounting for equity instruments exchanged for services, on January 1, 2006.

Under the provisions of SFAS 123(R), share-based compensation cost is measured at the grant date, based on the fair value of the award, and is recognized as an expense over the employee s requisite service period (generally the vesting period of the equity grant).

The Company s total actual share-based compensation expense for the six months ended June 30, 2008 and 2007 are \$6,890,000 and \$11,003,000, respectively.

The fair value of each option grant and share granted are estimated on the date of grant using the Black-Scholes option pricing model with the following assumptions used for grants during the applicable period.

	Six months ender 2008	ed June 30, 2007	
Option grants			
Average risk-free rate of return	2.42%	4.64%	
Expected term	1-4 years	2-4 years	
Volatility rate	36.45%	37.61%	
Expected dividend yield	0%	0%	

5. Share-based Compensation (Continued)

Share-based compensation plans

The Company s employee stock option plans (the Plans) allow the Company to offer a variety of incentive awards to employees, consultants or external service advisors of the Company.

In 2004, the Company adopted the 2004 Stock Option Plan (2004 Option Plan) whereby the Company grants stock options to attract, retain and motivate employees, directors and service providers. Following the completion of the IPO, the Company began issuing stock options solely through the 2004 Option Plan. Options to purchase 1,317,000,000 ordinary shares are authorized under the 2004 Option Plan. Under the terms of the 2004 Option Plan options are granted at the fair market value of the Company s ordinary shares. The majority of the options have a contractual life of 10 years from the date of grant and vest over a requisite service period of 4 years. Any compensation expense is recognized on a straight-line basis over the employee service period. As of June 30, 2008, options to purchase 594,454,845 ordinary shares were available for future grants.

In 2001, the Company adopted the 2001 Stock Option Plan (2001 Option Plan). Options to purchase 998,675,840 ordinary shares and 536,566,500 Series A convertible preference shares are authorized under the 2001 Option Plan. Options to purchase Series A convertible preference shares were converted into options to purchase ordinary shares immediately prior to the completion of the IPO. Under the terms of the 2001 Option Plan, options are generally granted at prices equal to the fair market value as estimated by the Board of Directors. The majority of the options have a contractual life of 10 years from the date of grant and vest over a requisite service period of 4 years. Any compensation expense is recognized on a straight-line basis over the employee service period. As of June 30, 2008, options to purchase 357,059,386 ordinary shares were outstanding. As of June 30, 2008, options to purchase 399,085,607 ordinary shares were available for future grant. However, following the IPO, the Company no longer issues stock options under the 2001 Option Plan.

A summary of the stock option activities and additional information regarding options outstanding as of June 30, 2008 is as follows:

	Number	Weighted average exercise price		Weighted average remaining contractual	Aggregate				
	of options			life	intrinsic value				
Outstanding at January 1, 2008	1,042,398,482	\$	0.14						
Granted	129,841,000	\$	0.08						
Exercised	17,323,422	\$	0.04						
Cancelled or forfeited	75,995,029	\$	0.13						
Outstanding at June 30, 2008	1,078,921,031	\$	0.13	6.96 years	35,880,135				
Vested or expected to vest at June 30, 2008	896,839,933	\$	0.13	6.72 years	30,743,470				
Exercisable at June 30, 2008	494,533,238	\$	0.07	5.34 years	35,130,292				
During the six months ended June 30, 2008 and 2007, the total intrinsic value of the options exercised were \$970,000									

During the six months ended June 30, 2008 and 2007, the total intrinsic value of the options exercised were \$970,000 and \$4,780,000, respectively.

5. Share-based Compensation (Continued)

Share-based compensation plans (*Continued*)

Certain options were granted to non-employees that resulted in a share-based compensation of \$211,000 and \$318,000 during the six months ended June 30, 2008 and 2007, respectively.

The weighted-averaged grant date fair value of options granted for the six months ended June 30, 2008 and 2007 was \$0.03 and \$0.05, respectively.

Restricted share units

In January 2004, the Company adopted the 2004 Equity Incentive Plan (2004 EIP) whereby the Company provided additional incentives to the Company s employees, directors and external consultants through the issuance of restricted shares, restricted share units and stock appreciation rights to the participants at the discretion of the Board of Directors. Under the 2004 EIP, the Company was authorized to issue up to 2.5% of the issued and outstanding ordinary shares immediately following the closing of its initial public offering in March 2004, which were 455,409,330 ordinary shares. As of June 30, 2008, 131,929,729 restricted share units were outstanding and 196,692,231 ordinary shares were available for future grant through the issuance of restricted shares, restricted share units and stock appreciation rights. The RSUs vest over a requisite service period of four years and expire 10 years from the date of grant. Any compensation expense is recognized on a straight-line basis over the employee service period.

A summary of the restricted share unit activities is as follows:

	Number	,	Weighted average exercise	Weighted average remaining contractual	Aggregate
	of share units		price	life	fair value
Outstanding at January 1, 2008	119,442,808	\$	0.14		
Granted	39,827,100	\$	0.08		
Vested	(17,900,836)	\$	0.15		
Cancelled or forfeited	(9,439,343)	\$	0.12		
Outstanding at June 30, 2008	131,929,729	\$	0.13	8.18 years	16,669,108
Vested or expected to vest at June 30, 2008	54,871,533	\$	0.09	9.49 years	5,016,675

Pursuant to the 2004 EIP, the Company granted 39,827,100 restricted share units during the six months ended June 30, 2008 and the fair value of the restricted share units at the date of grant was \$3,268,830 which is expensed over the vesting period. As a result, the Company has recorded a compensation expense of \$3,692,000 during the six months ended June 30, 2008.

Unrecognized compensation cost related to non-vested share-based compensation

As of June 30, 2008, there was \$18,098,000 of total unrecognized compensation cost related to non-vested share-based compensation arrangements granted under the 2001 Stock Option Plan, 2004 Stock Option Plan and 2004 EIP. The cost is expected to be recognized over a weighted-average period of 1.30 years.

6. Restricted cash

Restricted cash consists of bank time deposits pledged against short-term loans granted to the Company.

7. Account Receivable, Net Of Allowances

The Company determines credit terms for each customer on a case-by-case basis, based on its assessment of such customer s financial standing.

An aging analysis of trade debtors is as follows:

	June 30, 2008			
Current	\$	200,084	\$	249,490
Overdue:				
Within 30 days		17,010		39,132
Between 31 to 60 days		10,144		6,108
Over 60 days		35,180		3,658
	\$	262,418	\$	298,388
8. Inventories				
	J	June 30,	December 31,	
		2008		2007
Raw materials	\$	97,433	\$	83,646
Work in progress		109,604		139,959
Finished goods		45,357		24,705
	\$	252,394	\$	248,310

9. Plant and equipment, net

During the six month ended June 30, 2008, the Company reached an agreement with certain customers to discontinue production of DRAM products and subsequently the Company s Board of Directors decided to exit the commodity DRAM business as a whole. The Company considered these actions to be an indicator of impairment in regard to the plant and equipment in the Company s Beijing facility. Based on a detailed analysis, the Company recorded an impairment loss of \$105,774,000, equal to the excess of the carrying value over the fair value of the associated assets. The Company computed the fair value of the plant and equipment utilizing a discounted cash flow approach.

10. Accounts Payable

An aging analysis of the accounts payable is as follows:

	June 30, 2008			December 31, 2007	
Current	\$	266,053	\$	223,528	
Overdue:					
Within 30 days		33,250		46,572	
Between 31 to 60 days		18,669		10,227	
Over 60 days		27,829		21,666	
	\$	345,801	\$	301,993	

11. Indebtedness

Long-term and short-term debt is as follows:

	Maturity	Interest rate	June 30, 2008	Dec	cember 31, 2007
Shanghai USD syndicate loan	2006-2010	3.65%-5.76%	\$ 329,980	\$	393,910
Beijing USD syndicate loan	2006-2010	4.78%-6.38%	400,040		500,020
EUR syndicate loan	2005-2012	4.62%-5.87%	47,902		51,058
Tianjin USD syndicate loan	2007-2012	4.08%-6.03%	259,000		12,000
			1,036,922		956,988
Less: Current portion of long-term debts			341,630		340,693